

# Serial I<sup>2</sup>C bus RTC with battery switchover

#### **Features**

- Ultra-low battery supply current of 365 nA
- Factory calibrated accuracy ±5 ppm guaranteed after 2 reflows (SOX18)
  - Much better accuracies achievable using built-in programmable analog and digital calibration circuits
- 2.0 V to 5.5 V clock operating voltage
- Counters for tenths/hundredths of seconds, seconds, minutes, hours, day, date, month, year, and century
- Automatic switchover and reset output circuitry (fixed reference)
  - M41T83S  $V_{CC} = 3.00 \text{ V to } 5.50 \text{ V}$  $(2.85 \text{ V} \le V_{BST} \le 3.00 \text{ V})$
  - M41T83R  $V_{CC} = 2.70 \text{ V to } 5.50 \text{ V}$  $(2.55 \text{ V} \le V_{BST} \le 2.70 \text{ V})$
  - M41T83Z  $V_{CC} = 2.38 \text{ V to } 5.50 \text{ V}$  $(2.25 \text{ V} \le V_{BST} \le 2.38 \text{ V})$
- Serial interface supports I<sup>2</sup>C bus (400 kHz protocol)
- Programmable alarm with interrupt function (valid even during battery backup mode)
- Optional 2<sup>nd</sup> programmable alarm available
- Square wave output defaults to 32 KHz on power-up (M41T83 only)
- RESET (RST) output
- Watchdog timer
- Programmable 8-bit counter/timer
- 7 bytes of battery-backed user SRAM
- Battery low flag
- Power-down time stamp (HT bit)
- Low operating current of 80 µA



QFN16, 4 mm x 4 mm (QA) (VFQFPN16)



SOX18 (18-pin, 300 mil SOIC with embedded crystal) (MY)



SO8 (M)

- Oscillator stop detection
- Battery or SuperCap<sup>™</sup> backup
- Operating temperature of -40 °C to 85 °C
- Package options include:
  - a 16-lead QFN (M41T83),
  - an 18-lead embedded crystal SOIC (M41T83), or
  - an 8-lead SOIC (M41T82)
- RoHS compliance: lead-free components are compliant with the RoHS directive

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Description M41T82-M41T83

### 1 Description

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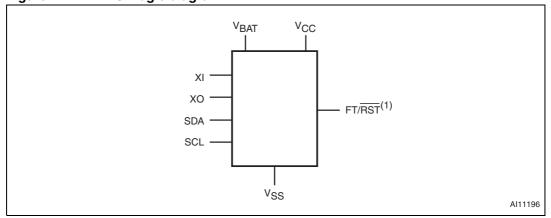
The M41T8x are low power serial I<sup>2</sup>C real-time clocks with a built-in 32.768 kHz oscillator (external crystal-controlled for the QFN16 and SO8 packages, embedded crystal for the SOX18 package). Eight bytes of the register map (see *Table 2 on page 21*) are used for the clock/calendar function and are configured in binary coded decimal (BCD) format. An additional 17 bytes of the register map provide status/control of the two alarms, watchdog, 8-bit counter, and square wave functions. An additional seven bytes are made available as user SRAM.

Addresses and data are transferred serially via a two-line, bidirectional I<sup>2</sup>C interface. The built-in address register is incremented automatically after each WRITE or READ data byte. The M41T8x has a built-in power sense circuit which detects power failures and automatically switches to the battery supply when a power failure occurs. The energy needed to sustain the clock operations can be supplied by a small lithium button battery when a power failure occurs.

Functions available to the user include a non-volatile, time-of-day clock/calendar, two alarm interrupts, watchdog timer, programmable 8-bit counter, and square wave outputs. The eight clock address locations contain the century, year, month, date, day, hour, minute, second, and tenths/hundredths of a second in 24-hour BCD format. Corrections for 28, 29 (leap year), 30, and 31 day months are made automatically. The M41T83 is supplied in either a QFN16 (QA) or an SOX18 (MY), 300 mil SOIC which includes an embedded 32 KHz crystal. The SOX18 package requires only a user-supplied battery to provide non-volatile operation. The M41T82 is available only in an SO8 (M) package.

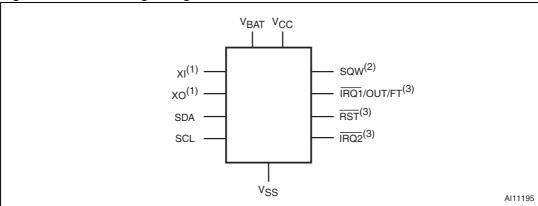
M41T82-M41T83 Description

Figure 1. M41T82 logic diagram



1. Open drain

Figure 2. M41T83 logic diagram



- 1. For QFN16 package only
- 2. Defaults to 32 KHz on power-up
- 3. Open drain

Description M41T82-M41T83

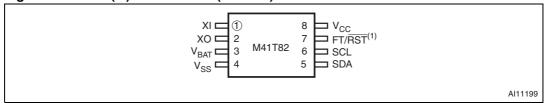
Table 1. Signal names

Symbol	Description
XI <sup>(1)</sup>	32 KHz oscillator input
XO <sup>(1)</sup>	32 KHz oscillator output
ĪRQ1/OUT/FT <sup>(2)</sup>	Interrupt 1/output driver/frequency test output (open drain)
SQW <sup>(3)</sup>	32 KHz programmable square wave output
RST	Power-on reset output (open drain)
FT/RST	Frequency test output/power-on reset (open drain - M41T82 only)
ĪRQ2 <sup>(2)</sup>	Interrupt for alarm 2 (open drain)
SDA	Serial data address input/output
SCL	Serial clock input
V <sub>BAT</sub>	Battery supply voltage (tie V <sub>BAT</sub> to V <sub>SS</sub> if no battery is connected.)
DU <sup>(4)</sup>	Do not use
V <sub>CC</sub>	Supply voltage
V <sub>SS</sub>	Ground

- 1. For SO8 and QFN16 packages only.
- 2. For SOX18 and QFN16 packages only.
- 3. Defaults to 32 KHz on power-up.
- 4. DU pin must be tied to  $V_{\mbox{\footnotesize CC}}.$

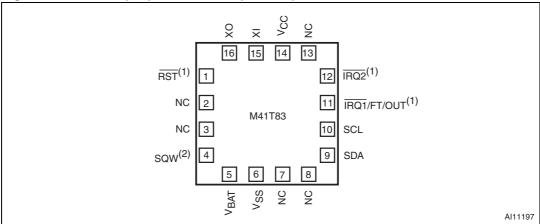
M41T82-M41T83 Description

Figure 3. SO8 (M) connections (M41T82)



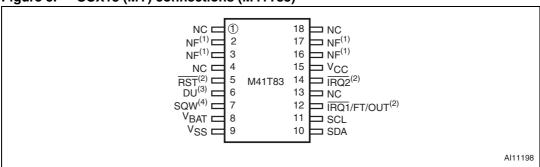
1. Open drain output

Figure 4. QFN16 (QA) connections (M41T83)



- 1. Open drain output.
- 2. Defaults to 32 KHz on power-up.

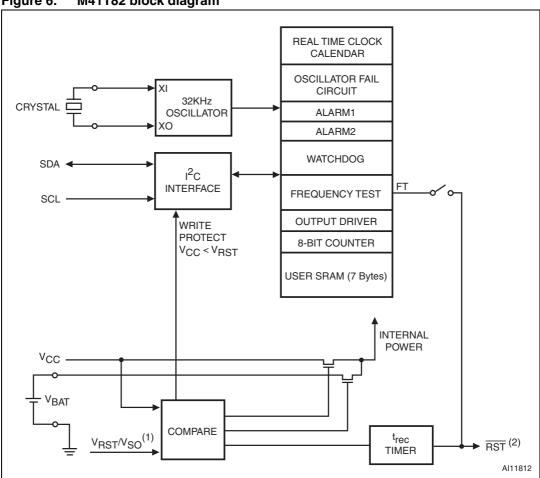
Figure 5. SOX18 (MY) connections (M41T83)



- 1. NF pins must be tied to  $V_{SS}$ . Pins 2 and 3, and 16 and 17 are internally shorted together.
- 2. Open drain output.
- 3. Do not use (must be tied to  $V_{CC}$ ).
- 4. Defaults to 32 KHz on power-up.

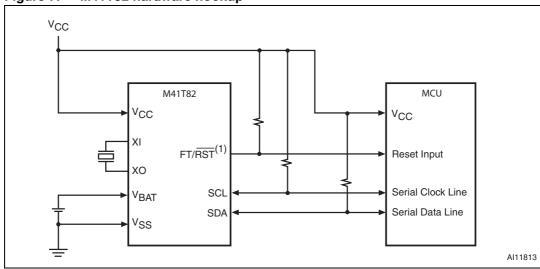
Description M41T82-M41T83

Figure 6. M41T82 block diagram



- 1.  $V_{RST} = V_{SO} = 2.93 \text{ V (S)}, 2.63 \text{ V (R)}, \text{ and } 2.32 \text{ V (Z)}.$
- 2. Open drain output.

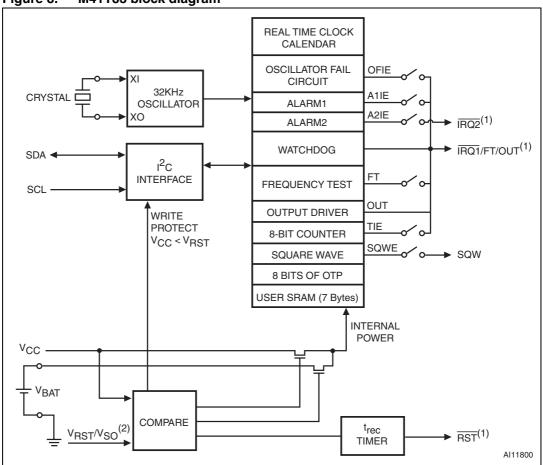
Figure 7. M41T82 hardware hookup



1. Open drain output.

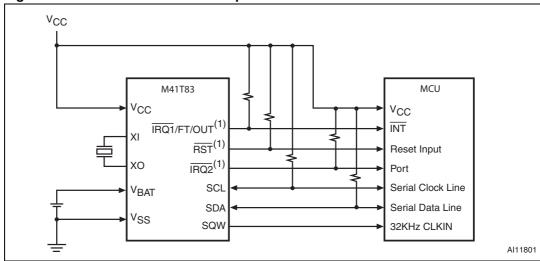
M41T82-M41T83 Description

Figure 8. M41T83 block diagram



- 1. Open drain output.
- 2.  $V_{RST} = V_{SO} = 2.93 \text{ V (S)}, 2.63 \text{ V (R)}, \text{ and } 2.32 \text{ V (Z)}.$

Figure 9. M41T83 hardware hookup



1. Open drain output.

Operation M41T82-M41T83

### 2 Operation

The M41T8x clock operates as a slave device on the serial bus. Access is obtained by implementing a start condition followed by the correct slave address (D0h). The 32 bytes contained in the device can then be accessed sequentially in the following order:

- 1<sup>st</sup> byte: tenths/hundredths of a second register
- 2<sup>nd</sup> byte: seconds register
- 3<sup>rd</sup> byte: minutes register
- 4<sup>th</sup> byte: century/hours register
- 5<sup>th</sup> byte: day register
- 6<sup>th</sup> byte: date register
- 7<sup>th</sup> byte: month register
- 8<sup>th</sup> byte: year register
- 9<sup>th</sup> byte: digital calibration register
- 10<sup>th</sup> byte: watchdog register
- 11<sup>th</sup> 15<sup>th</sup> bytes: alarm 1 registers
- 16<sup>th</sup> byte: flags register
- 17<sup>th</sup> byte: timer value register
- 18<sup>th</sup> byte: timer control register
- 19<sup>th</sup> byte: analog calibration register
- 20<sup>th</sup> byte: square wave register
- 21<sup>st</sup> 25<sup>th</sup> bytes: alarm 2 registers
- 26<sup>th</sup> 32<sup>nd</sup> bytes: user RAM

The M41T8x clock continually monitors  $V_{CC}$  for an out-of-tolerance condition. Should  $V_{CC}$  fall below  $V_{RST}$ , the device terminates an access in progress and resets the device address counter. Inputs to the device will not be recognized at this time to prevent erroneous data from being written to the device from an out-of-tolerance system. The power input will also be switched from the  $V_{CC}$  pin to the battery when  $V_{CC}$  falls below the battery back-up switchover voltage ( $V_{SO} = V_{RST}$ ). At this time the clock registers will be maintained by the attached battery supply. As system power returns and  $V_{CC}$  rises above  $V_{SO}$ , the battery is disconnected, and the power supply is switched to external  $V_{CC}$ .

M41T82-M41T83 Operation

### 2.1 2-wire bus characteristics

The bus is intended for communication between different ICs. It consists of two lines: a bidirectional data signal (SDA) and a clock signal (SCL). Both the SDA and SCL lines must be connected to a positive supply voltage via a pull-up resistor.

The following protocol has been defined:

- Data transfer may be initiated only when the bus is not busy.
- During data transfer, the data line must remain stable whenever the clock line is high.
- Changes in the data line, while the clock line is high, will be interpreted as control signals.

Accordingly, the following bus conditions have been defined:

### 2.1.1 Bus not busy

Both data and clock lines remain high.

#### 2.1.2 Start data transfer

A change in the state of the data line, from high to low, while the clock is high, defines the START condition.

### 2.1.3 Stop data transfer

A change in the state of the data line, from low to high, while the clock is high, defines the STOP condition.

#### 2.1.4 Data valid

The state of the data line represents valid data when after a start condition, the data line is stable for the duration of the high period of the clock signal. The data on the line may be changed during the low period of the clock signal. There is one clock pulse per bit of data. Each data transfer is initiated with a start condition and terminated with a stop condition. The number of data bytes transferred between the start and stop conditions is not limited. The information is transmitted byte-wide and each receiver acknowledges with a ninth bit.

By definition a device that gives out a message is called "transmitter," the receiving device that gets the message is called "receiver." The device that controls the message is called "master." The devices that are controlled by the master are called "slaves."

Operation M41T82-M41T83

### 2.1.5 Acknowledge

Each byte of eight bits is followed by one acknowledge bit. This acknowledge bit is a low level put on the bus by the receiver whereas the master generates an extra acknowledge related clock pulse. A slave receiver which is addressed is obliged to generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.

The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is a stable low during the high period of the acknowledge related clock pulse. Of course, setup and hold times must be taken into account. A master receiver must signal an end of data to the slave transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this case the transmitter must leave the data line high to enable the master to generate the STOP condition.



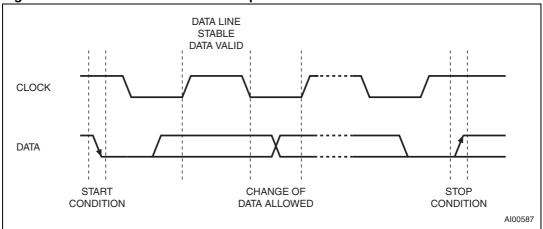
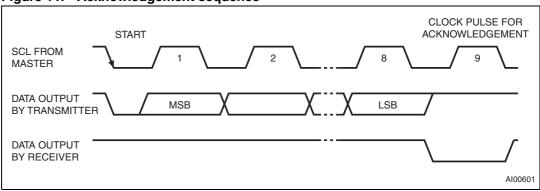


Figure 11. Acknowledgement sequence



M41T82-M41T83 Operation

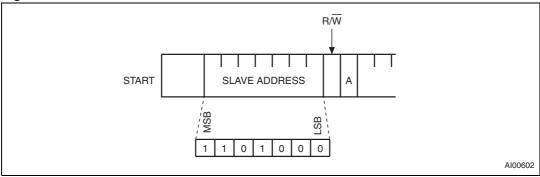
### 2.2 Read mode

In this mode the master reads the M41T8x slave after setting the slave address (see *Figure 13 on page 16*). Following the WRITE mode control bit (R/W = 0) and the acknowledge bit, the word address 'An' is written to the on-chip address pointer. Next the START condition and slave address are repeated followed by the READ mode control bit (R/W = 1). At this point the master transmitter becomes the master receiver. The data byte which was addressed will be transmitted and the master receiver will send an acknowledge bit to the slave transmitter. The address pointer is only incremented on reception of an acknowledge clock. The M41T8x slave transmitter will now place the data byte at address An+1 on the bus, the master receiver reads and acknowledges the new byte and the address pointer is incremented to An+2.

This cycle of reading consecutive addresses will continue until the master receiver sends a STOP condition to the slave transmitter. Most of the registers and memory locations are accessed directly, but the RTC counters are accessed via a set of buffer/transfer registers at addresses 00h to 07h. The counters are not directly read nor written. Instead, at the start of a read or write cycle, the counters are copied into the eight buffer/transfer registers so that the user can read them out sequentially, receiving a coherent set of data, copied from the same instant in time.

An alternate READ mode may also be implemented whereby the master reads the M41T8x slave without first writing to the (volatile) address pointer. The first address that is read is the last one stored in the pointer (see *Figure 14 on page 16*).

Figure 12. Slave address location



Operation M41T82-M41T83

Figure 13. Read mode sequence

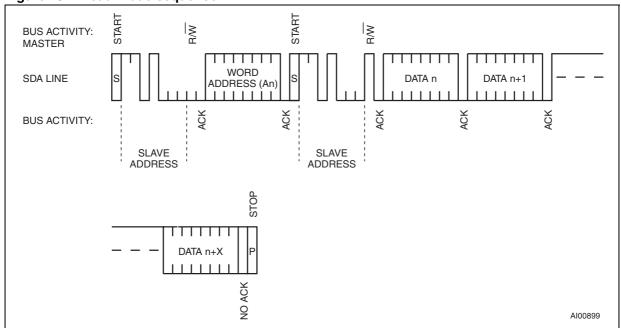
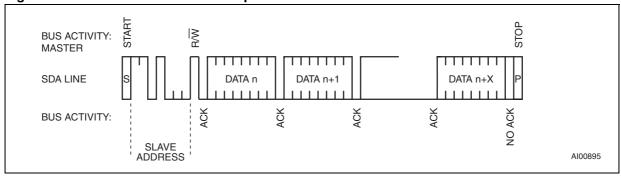


Figure 14. Alternative read mode sequence

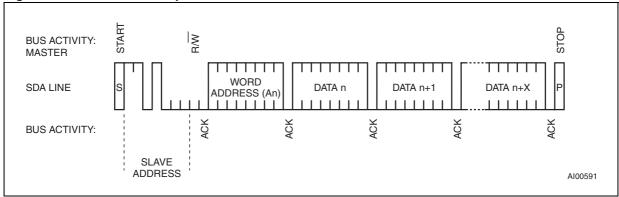


M41T82-M41T83 Operation

### 2.3 Write mode

In this mode the master transmitter transmits to the M41T8x slave receiver. Bus protocol is shown in *Figure 15*. Following the START condition and slave address, a logic 0 (R/W = 0) is placed on the bus and indicates to the addressed device that word address "An" will follow and is to be written to the on-chip address pointer. The data word to be written to the memory is strobed in next and the internal address pointer is incremented to the next address location on the reception of an acknowledge clock. The M41T8x slave receiver will send an acknowledge clock to the master transmitter after it has received the slave address see *Figure 12 on page 15* and again after it has received the word address and each data byte.

Figure 15. Write mode sequence



As in the case of reading, some registers and memory locations are written directly, but the RTC counters are written via a set of eight buffer/transfer registers at addresses 00h to 07h. The user will write the date and time information sequentially, and then, at the end of the I<sup>2</sup>C write cycle or when the address pointer increments beyond 07h, the buffer/transfer registers will be copied into the RTC counters. All the time parameters - fractions, seconds, minutes, hours, day, date, month, year, and century bits - are copied simultaneously.

Whatever value is in the buffer/transfer registers will be copied to the counters, so if the user only changes one of the eight bytes, the remaining seven bytes will receive the unchanged contents of the buffer/transfer registers, which will contain whatever was in the counters at the start of the write access.

For example, if the user starts a write cycle on Monday, November 16, 2009, at 17:52:27.03, and writes a 22 to the minutes registers, the value Monday, November 16, 2009, 17:52:22.03 will be written back into the counters. At the start of the write cycle, the eight bytes of counters were copied into the buffer/transfer registers. Then, the seconds register was overwritten. Finally, the eight bytes were copied back into the counters with the result that the seconds value was changed.

Operation M41T82-M41T83

## 2.4 Data retention and battery switchover $(V_{SO} = V_{RST})$

Once  $V_{CC}$  falls below the switchover voltage ( $V_{SO} = V_{RST}$ ), the device automatically switches over to the battery and powers down into an ultra low current mode of operation to preserve battery life. If  $V_{BAT}$  is less than, or greater than  $V_{RST}$ , the device power is switched from  $V_{CC}$  to  $V_{BAT}$  when  $V_{CC}$  drops below  $V_{RST}$  (see *Figure 26 on page 50*). At this time the clock registers and user RAM will be maintained by the attached battery supply.

When it is powered back up, the device switches back from battery to  $V_{CC}$  at  $V_{SO}$  + hysteresis. When  $V_{CC}$  rises above  $V_{RST}$ , it will recognize the inputs. For more information on battery storage life refer to Application Note AN1012.

### 2.5 Power-on reset $(t_{rec})$

The M41T8x continuously monitors  $V_{CC}$ . When  $V_{CC}$  falls to the power fail detect trip point, the  $\overline{RST}$  output pulls low (open drain) and remains low after power-up for  $t_{rec}$  (210 ms typical) after  $V_{CC}$  rises above  $V_{RST}$  (max).

Note:

The  $t_{rec}$  period does not affect the RTC operation. Write protect only occurs when  $V_{CC}$  is below  $V_{RST}$ . When  $V_{CC}$  rises above  $V_{RST}$ , the RTC will be selectable immediately. Only the RST output is affected by the  $t_{rec}$  period.

The  $\overline{RST}$  pin is an open drain output and an appropriate pull-up resistor to  $V_{CC}$  should be chosen to control the rise time.

Doc ID 12578 Rev 12

#### **Clock operation** 3

The M41T8x is driven by a quartz-controlled oscillator with a nominal frequency of 32.768 kHz. The accuracy of the real-time clock depends on the frequency of the quartz crystal that is used as the time-base for the RTC.

The 8-byte clock register (see Table 2 on page 21 and Table 4 on page 23) is used to both set the clock and to read the date and time from the clock, in binary coded decimal format. Tenths/hundredths of seconds, seconds, minutes, and hours are contained within the first four registers.

Bit D7 of register 01h contains the STOP bit (ST). Setting this bit to a '1' will cause the oscillator to stop. When reset to a 0 the oscillator restarts within one second (typical).

Note: Upon initial power-up, the user should set the ST bit to a '1,' then immediately reset the ST bit to 0. This provides an additional "kick-start" to the oscillator circuit.

> Bits D6 and D7 of clock register 03h (century/ hours register) contain the CENTURY bit 0 (CB0) and CENTURY bit 1 (CB1). Bits D0 through D2 of register 04h contain the day (day of week). Registers 05h, 06h, and 07h contain the date (day of month), month, and years. The ninth clock register is the digital calibration register, while the analog calibration register is found at address 12h (these are both described in Section 3.4: Clock calibration). The RTC includes an oscillator fail detect circuit which sets the OF bit in the flags register (bit 2, register 0fh). For the M41T83, bit D7 of register 09h (watchdog register) contains the oscillator fail interrupt enable bit (OFIE) which can be used to enable an interrupt when the OF bit is set (see Section 3.12: Oscillator fail detection on page 40) will also generate an interrupt output.

> A WRITE to ANY location within the first eight bytes of the clock register (00h-07h), including the ST bit and CB0-CB1 bits will result in an update of the RTC counters and a reset of the divider chain. This could result in an inadvertent change of the current time. For example, the ST bit is in the seconds register (address 01h) and the century bits (CB0-CB1) are in the hours register (address 03h), so the user should take care to not alter these other parameters when changing the ST bit or the century bits.

> The eight clock registers may be read one byte at a time or in a sequential block. At the start of a read cycle, a copy of the time/date counters is placed in the buffer/transfer registers and can then be transferred out sequentially without concern that the time/date increments during the transfer and thus yields a corrupt value. For example, if the user were to read the seconds register, then start another bus cycle to read the minutes register, the minutes counter could have incremented during the time between the two read cycles. The seconds and minutes values would not be from the same instant in time; they would not be coherent. By using the sequential read feature, the values shifted out are from the same instant in time and are thus coherent.

> Similarly, when writing to the RTC registers, during one write cycle, the user can sequentially transfer all eight bytes of time/date into the buffer/transfer registers whereupon they will be loaded simultaneously into the RTC counters thus ensuring a coherent update of the time/date.

Note:

### 3.1 Power-down time-stamp

When a power failure occurs, the time/date counters are copied into the buffer/transfer registers and the halt update bit (HT) is automatically set to a "1". The HT bit prevents the normal copying from counters to registers which occurs at the start of a read or write cycle. Thus, upon power-up, the user can read the RTC registers to ascertain the time of power-down. Additional reads will return the same time. It will appear to be frozen until the HT bit (D6, address 0Ch) is written to 0 by the user. Then, subsequent reads will then return the current time. For more information, see application notes AN1572 and AN3060.

Note:

Writes to the RTC registers (addresses 00h to 07h) with the HT bit set can cause time corruption. Example: Assume a power-fail time of Monday, November 16, 2009, at 17:52:27.03. At the next power-up, that time will be frozen in the buffer/transfer registers. On November 17, 2009, at 16:15:07.77, the user powers the system back up and tries to write the seconds to 35 while the HT bit is still set. This will cause Monday, November 16, 2009, at 17:52:35.03 to be written into the counters because the other seven bytes of buffer/transfer register still contain the time of power-down. The result is that the modified time of power-down was written into the counters making it appear the part had lost time while power was off. Thus, at power-up, the user should always clear the HT bit (write D6 to 0 in address 0Ch) before writing to any address in the range 00h to 07h.

A typical power-up flow is to read the time of power-down, then clear the HT bit, then read the current time. If the time of power-down is not needed by the application, then the first step can be omitted.

### 3.2 Clock/control register map and divider chain

The M41T8x is comprised of 32 addresses which contain registers for clock (time and date), calibration (digital and analog), alarm 1 and 2, watchdog, flags, timer, and square wave (M41T83 only). Clock and alarm registers store data in BCD format. Calibration, timer, watchdog, and square wave bits are written in a binary format.

Whenever any of the eight RTC bytes (addresses 00h to 07h) are written, the internal divider (or clock) chain will be reset upon the completion of the write cycle.

Table 2. M41T82 clock/control register map (32 bytes)<sup>(1)</sup>

									Function/rang	e BCD
Addr	D7	D6	D5	D4	D3	D2	D1	D0	format	
00h		0.1 se	econds			0.01 s	econds		seconds	00-99
01h	ST	10 seconds				seco	onds		seconds	00-59
02h	0		10 minute	S		min	utes		minutes	00-59
03h	CB1	CB0	10 h	nours	Но	ours (24 h	our form	at)	Century/hours	0-3/00-23
04h	0	0	0	0	0	D	ay of wee	ek	Day	01-7
05h	0	0	10	date	I	Date: day	of month	1	Date	01-31
06h	0	0	0	10M		Мо	nth		Month	01-12
07h		10 years				Ye	ar		Year	00-99
08h	0	FT	DCS	DC4	DC3	DC2	DC1	DC0	Digital calibration	
09h	0	BMB4	BMB3	BMB2	BMB1	BMB0	RB1	RB0	Watchdog	
0Ah	0	0	ABE	Al1 10M	Alarm1 month				Al1 month	01-12
0Bh	RPT14	RPT15	Al1 1	0 date	Alarm1 date				Al1 date	01-31
0Ch	RPT13	HT	Al1 1	0 hour		Alarm1 hour			Al1 hour	00-23
0Dh	RPT12	Alarm1 10 minutes			Alarm1 minutes			Al1 min	00-59	
0Eh	RPT11	Aları	m1 10 sec	onds	Alarm1 seconds			Al1 sec	00-59	
0Fh	WDF	AF1	AF2 <sup>(2)</sup>	BL	TF	OF	0	0	Flags	
10h			Tin	ner countd	own valu	е			Timer value	
11h	TE	0	0	0	0	0	TD1	TD0	Timer control	
12h	ACS	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Analog calibration	
13h	0	0	0	0	0	0	AL2E	0	SQW	
14h	0 <sup>(3)</sup>	0 <sup>(3)</sup>	0 <sup>(3)</sup>	Al2 10M		Alarm2	month		SRAM/Al2 month	01-12
15h	RPT24	RPT25	Al2 1	0 date		Alarm2	month	SRAM/Al2 date	01-31	
16h	RPT23	0(3)	Al2 1	0 hour		Alarm	2 date	SRAM/Al2 hour	00-23	
17h	RPT22	Alar	m2 10 mir	nutes		Alarm2		SRAM/Al2 min	00-59	
18h	RPT21	Aları	m2 10 sec	onds		Alarm2	seconds		SRAM/Al2 sec	00-59
19h-1Fh			U	ser SRAM	(7 bytes)				SRAM	

<sup>1.</sup> See Table 3: Key to Table 2: M41T82 clock/control register map (32 bytes)

<sup>2.</sup> AF2 will always read 0, if the AL2E bit is set to 0.

<sup>3.</sup> As indicated in *Table 3*, the 0 bits should be written to 0. But in the case of these four bits, when AL2E is 0, registers 14-18h are SRAM locations and these bits become SRAM cells which are thus excluded from that restriction.

Table 3. Key to Table 2: M41T82 clock/control register map (32 bytes)

Code	Explanation
0	Must be set to zero
ABE	Alarm in battery backup enable bit
AC0-AC6	Analog calibration bits
ACS	Analog calibration sign bit
AF1, AF2	Alarm flag bits
AL2E	Alarm 2 enable bit
BL	Battery low bit
BMB0-BMB4	Watchdog multiplier bits
CB0, CB1	Century bits
DC0-DC4	Digital calibration bits
DCS	Digital calibration sign bit
FT	Frequency test bit
нт	Halt update bit
OF	Oscillator fail bit
RB0-RB2	Watchdog resolution bits
RPT11-RPT15	Alarm 1 repeat mode bits
RPT21-RPT25	Alarm 2 repeat mode bits
ST	Stop bit
TD0, TD1	Timer frequency bits
TE	Timer enable bit
TF	Timer flag
WDF	Watchdog flag

Table 4. M41T83 clock/control register map (32 bytes)<sup>(1)</sup>

Addr									Function/rang	ge BCD
	D7	D6	D5	D4	D3	D2	D1	D0	format	
00h		0.1 se	conds		0.01 seconds				seconds	00-99
01h	ST	1	0 second	S		seco	onds	seconds	00-59	
02h	0	-	10 minute:	3		Min	utes		Minutes	00-59
03h	CB1	CB0 10 hours			Н	ours (24 h	our forma	at)	Century/hours	0-3/00-23
04h	0	0	0	0	0	С	ay of wee	ek	Day	01-7
05h	0	0	10 (	date		Date: day	of month		Date	01-31
06h	0	0	0	10M		Мо	nth		Month	01-12
07h		10 years				Ye	ar		Year	00-99
08h	OUT	FT	DCS	DC4	DC3	DC2	DC1	DC0	Digital calibration	
09h	OFIE	BMB4	BMB3	BMB2	BMB1	BMB0	RB1	RB0	Watchdog	
0Ah	A1IE	SQWE	ABE	Al1 10M	Alarm 1month				Al1 month	01-12
0Bh	RPT14	RPT15	Al1 10	) date		Alarm	1 date	Al1 date	01-31	
0Ch	RPT13	HT	Al1 10	) hour		Alarm	1 hour	Al1 hour	00-23	
0Dh	RPT12	Aları	m1 10 mir	utes	Alarm1 minutes				Al1 min	00-59
0Eh	RPT11	Alarr	n1 10 sec	onds	Alarm1 seconds				Al1 sec	00-59
0Fh	WDF	AF1	AF2 <sup>(2)</sup>	BL	TF	OF	0	0	Flags	
10h			Ti	mer coun	tdown val	ue		•	Timer value	
11h	TE	TI/TP	TIE	0	0	0	TD1	TD0	Timer control	
12h	ACS	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Analog calibration	
13h	RS3	RS2	RS1	RS0	0	0	AL2E	OTP	SQW	
14h	A2IE	0 <sup>(3)</sup>	0 <sup>(3)</sup>	Al2 10M		Alarm2	2 month	SRAM/Al2 month	01-12	
15h	RPT24	RPT25	Al2 10	) date		Alarm	2 date	SRAM/Al2 date	01-31	
16h	RPT23	0(3)	Al2 10	) hour		Alarm	2 hour	SRAM/Al2 hour	00-23	
17h	RPT22	Aları	m2 10 mir	0 minutes Alarm2 minutes					SRAM/Al2 min	00-59
18h	RPT21	Alarr	n2 10 sec	onds		Alarm2	seconds		SRAM/Al2 sec	00-59
19h- 1Fh			l	Jser SRAI	M (7 bytes	s)			SRAM	

<sup>1.</sup> See Table 5: Key to Table 4: M41T83 clock/control register map (32 bytes).

<sup>2.</sup> AF2 will always read 0, if the AL2E bit is set to 0.

<sup>3.</sup> As indicated in *Table 5*, the 0 bits should be written to 0. But in the case of these three bits, when AL2E is 0, registers 14-18h are SRAM locations and these bits become SRAM cells which are thus excluded from that restriction.

Table 5. Key to Table 4: M41T83 clock/control register map (32 bytes)

Must be set to zero  ABE Alarm in battery back-up enable bit  A1IE, A2IE Alarm interrupt enable bits  ACO-AC6 Analog calibration bits  ACS Analog calibration sign bit  AF1, AF2 Alarm flag  AL2E Alarm 2 enable bit  BL Battery low bit  BMB0-BMB4 Watchdog multiplier bits  CB0, CB1 Century bits  DC0-DC4 Digital calibration bits  FT Frequency test bit  HT Halt update bit  OF Oscillator fail bit  OUT Output level  OFIE OSCILLATOR Tail interrupt enable  OTP OTP control bit  RB0-RB2 Watchdog resolution bits  RPT11-RPT15 Alarm 1 repeat mode bits  RPT21-RPT25 Alarm 2 repeat mode bits  SRAM/ALM2 SRAM/ALM2 SRAM/ALM2 SRAM/ALM2 SRAM/ALM2 SRAM/ALM2 SRAM/ALM2 SRAM/ALM2 SRAM/ALM2 Timer enable bit  TE Timer flag Ti/TP Timer interrupt or pulse	Code	Explanation
A1IE, A2IE ACO-AC6 Analog calibration bits ACS Analog calibration bits AF1, AF2 Alarm flag AL2E Alarm 2 enable bit BL Battery low bit BMB0-BMB4 Watchdog multiplier bits CB0, CB1 Century bits DC0-DC4 Digital calibration bits DCS Digital calibration Sign bit HT Halt update bit HT Halt update bit OF Oscillator fail bit OUT Output level OFIE OScillator fail interrupt enable OTP OTP control bit RB0-RB2 Watchdog resolution bits RPT11-RPT15 Alarm 1 repeat mode bits RS0-RS3 SQW frequency Square wave enable SRAM/ALM2 SRAM/ALM2 SRAM/ALM2 TE Timer frequency bits TE Timer enable bit Timer frequency bits Timer enable bit Timer frequency bits Timer enable bit Timer frequency bits Timer flag	0	Must be set to zero
ACO-AC6 Analog calibration bits ACS Analog calibration sign bit AF1, AF2 Alarm flag AL2E Alarm 2 enable bit BL Battery low bit BMB0-BMB4 Watchdog multiplier bits CB0, CB1 Century bits DC0-DC4 Digital calibration bits DCS Digital calibration Sign bit FT Frequency test bit HT Halt update bit OF Oscillator fail bit OUT Output level OFIE Oscillator fail interrupt enable OTP OTP control bit RB0-RB2 Watchdog resolution bits RPT11-RPT15 Alarm 1 repeat mode bits RPT21-RPT25 Alarm 2 repeat mode bits RS0-RS3 SQWE Square wave enable SRAM/ALM2 SRAM/alarm 2 bit ST Stop bit TD0, TD1 Timer frequency bits TE Timer enable bit Timer enable bit Timer flag	ABE	Alarm in battery back-up enable bit
ACS Analog calibration sign bit AF1, AF2 Alarm flag AL2E Alarm 2 enable bit BL Battery low bit BMB0-BMB4 Watchdog multiplier bits CB0, CB1 Century bits DC0-DC4 Digital calibration bits DCS Digital calibration Sign bit FT Frequency test bit HT Halt update bit OF Oscillator fail bit OUT Output level OFIE OScillator fail interrupt enable OTP OTP control bit RB0-RB2 Watchdog resolution bits RPT11-RPT15 Alarm 1 repeat mode bits RPT21-RPT25 Alarm 2 repeat mode bits RS0-RS3 SQWE Square wave enable SRAM/ALM2 SRAM/ALM2 SRAM/ALM2 TE Timer frequency bits TE Timer enable bit TF Timer enable bit TF Timer enable bit TF Timer enable bit TF Timer flag	A1IE, A2IE	Alarm interrupt enable bits
AF1, AF2         Alarm flag           AL2E         Alarm 2 enable bit           BL         Battery low bit           BMB0-BMB4         Watchdog multiplier bits           CB0, CB1         Century bits           DC0-DC4         Digital calibration bits           DCS         Digital calibration Sign bit           FT         Frequency test bit           HT         Halt update bit           OF         Oscillator fail bit           OUT         Output level           OFIE         Oscillator fail interrupt enable           OTP         OTP control bit           RB0-RB2         Watchdog resolution bits           RPT11-RPT15         Alarm 1 repeat mode bits           RPT21-RPT25         Alarm 2 repeat mode bits           RS0-RS3         SQW frequency           SQWE         Square wave enable           SRAM/ALM2         SRAM/alarm 2 bit           ST         Stop bit           TD0, TD1         Timer frequency bits           TE         Timer enable bit           TF         Timer flag	AC0-AC6	Analog calibration bits
AL2E BL Battery low bit BMB0-BMB4 Watchdog multiplier bits CB0, CB1 Century bits DC0-DC4 Digital calibration bits DCS Digital calibration Sign bit FT Frequency test bit HT Halt update bit OF Oscillator fail bit OUT Output level OFIE OScillator fail interrupt enable OTP OTP control bit RB0-RB2 Watchdog resolution bits RPT11-RPT15 Alarm 1 repeat mode bits RPT21-RPT25 Alarm 2 repeat mode bits RS0-RS3 SQWE Square wave enable SRAM/ALM2 SRAM/ALM2 SRAM/Alarm 2 bit ST TD0, TD1 Timer frequency bits TE Timer enable bit Timer enable bit Timer enable bit Timer flag	ACS	Analog calibration sign bit
BL Battery low bit  BMB0-BMB4 Watchdog multiplier bits  CB0, CB1 Century bits  DC0-DC4 Digital calibration bits  DCS Digital calibration Sign bit  FT Frequency test bit  HIT Halt update bit  OF Oscillator fail bit  OUT Output level  OFIE Oscillator fail interrupt enable  OTP OTP control bit  RB0-RB2 Watchdog resolution bits  RPT11-RPT15 Alarm 1 repeat mode bits  RPT21-RPT25 Alarm 2 repeat mode bits  RS0-RS3 SQW frequency  SQWE Square wave enable  SRAM/ALM2 SRAM/alarm 2 bit  ST Stop bit  TD0, TD1 Timer frequency bits  TE Timer enable bit  Timer enable bit  Timer flag	AF1, AF2	Alarm flag
BMB0-BMB4  CB0, CB1  Century bits  DC0-DC4  Digital calibration bits  DCS  Digital calibration Sign bit  FT  Frequency test bit  HT  Halt update bit  OF  Oscillator fail bit  OUT  Output level  OFIE  OSCIllator fail interrupt enable  OTP  OTP control bit  RB0-RB2  Watchdog resolution bits  RPT11-RPT15  Alarm 1 repeat mode bits  RPT21-RPT25  Alarm 2 repeat mode bits  RS0-RS3  SQW frequency  SQWE  Square wave enable  SRAM/ALM2  SRAM/ALM2  SRAM/alarm 2 bit  ST  Stop bit  TD0, TD1  Timer frequency bits  TE  Timer enable bit  Timer enable bit  Timer flag	AL2E	Alarm 2 enable bit
CB0, CB1  CC0-DC4  Digital calibration bits  DCS  Digital calibration Sign bit  FT  Frequency test bit  HT  Halt update bit  OF  Oscillator fail bit  OUT  Output level  OFIE  OSCIllator fail interrupt enable  OTP  OTP control bit  RB0-RB2  Watchdog resolution bits  RPT11-RPT15  Alarm 1 repeat mode bits  RPT21-RPT25  Alarm 2 repeat mode bits  RS0-RS3  SQW frequency  SQWE  Square wave enable  SRAM/ALM2  SRAM/ALM2  SRAM/alarm 2 bit  ST  Stop bit  TD0, TD1  Timer frequency bits  Timer enable bit  Timer enable bit  Timer enable bit	BL	Battery low bit
DCO-DC4 Digital calibration bits DCS Digital calibration Sign bit FT Frequency test bit HT Halt update bit OF Oscillator fail bit OUT Output level OFIE OScillator fail interrupt enable OTP OTP control bit RB0-RB2 Watchdog resolution bits RPT11-RPT15 Alarm 1 repeat mode bits RPT21-RPT25 Alarm 2 repeat mode bits RSO-RS3 SQW frequency SQWE Square wave enable SRAM/ĀLM2 SRAM/ĀLM2 SRAM/ALM2 ST Stop bit TD0, TD1 Timer frequency bits TE Timer enable bit Timer flag	BMB0-BMB4	Watchdog multiplier bits
DCS Digital calibration Sign bit FT Frequency test bit HT Halt update bit OF Oscillator fail bit OUT Output level OFIE OSCILLATOR TO STEPPEN TO	CB0, CB1	Century bits
FT Frequency test bit  HT Halt update bit  OF Oscillator fail bit  OUT Output level  OFIE Oscillator fail interrupt enable  OTP OTP control bit  RB0-RB2 Watchdog resolution bits  RPT11-RPT15 Alarm 1 repeat mode bits  RPT21-RPT25 Alarm 2 repeat mode bits  RS0-RS3 SQW frequency  SQWE Square wave enable  SRAM/ALM2 SRAM/alarm 2 bit  ST Stop bit  TD0, TD1 Timer frequency bits  Timer enable bit  Timer enable bit  Timer flag	DC0-DC4	Digital calibration bits
HT Halt update bit  OF Oscillator fail bit  OUT Output level  OFIE Oscillator fail interrupt enable  OTP OTP control bit  RB0-RB2 Watchdog resolution bits  RPT11-RPT15 Alarm 1 repeat mode bits  RPT21-RPT25 Alarm 2 repeat mode bits  RS0-RS3 SQW frequency  SQWE Square wave enable  SRAM/ALM2 SRAM/ALM2 SRAM/alarm 2 bit  ST Stop bit  TD0, TD1 Timer frequency bits  TE Timer enable bit  Timer enable bit  Timer flag	DCS	Digital calibration Sign bit
OF Oscillator fail bit OUT Output level OFIE Oscillator fail interrupt enable OTP OTP control bit RB0-RB2 Watchdog resolution bits RPT11-RPT15 Alarm 1 repeat mode bits RPT21-RPT25 Alarm 2 repeat mode bits RS0-RS3 SQW frequency SQWE Square wave enable SRAM/ALM2 SRAM/alarm 2 bit ST Stop bit TD0, TD1 Timer frequency bits TE Timer enable bit Timer enable bit	FT	Frequency test bit
OUT OFIE OSCILLATOR fail interrupt enable OTP OTP control bit  RB0-RB2 Watchdog resolution bits  RPT11-RPT15 Alarm 1 repeat mode bits  RPT21-RPT25 Alarm 2 repeat mode bits  RS0-RS3 SQW frequency SQWE Square wave enable SRAM/ALM2 SRAM/ALM2 SRAM/alarm 2 bit  ST Stop bit  TD0, TD1 Timer frequency bits  TE Timer enable bit  Timer flag	нт	Halt update bit
OFIE OTP OTP control bit  RB0-RB2 Watchdog resolution bits  RPT11-RPT15 Alarm 1 repeat mode bits  RPT21-RPT25 Alarm 2 repeat mode bits  RS0-RS3 SQW frequency  SQWE Square wave enable  SRAM/ALM2 SRAM/ALM2 ST TD0, TD1 Timer frequency bits  TE Timer enable bit  Timer flag	OF	Oscillator fail bit
OTP Control bit  RB0-RB2 Watchdog resolution bits  RPT11-RPT15 Alarm 1 repeat mode bits  RPT21-RPT25 Alarm 2 repeat mode bits  RS0-RS3 SQW frequency  SQWE Square wave enable  SRAM/ALM2 SRAM/alarm 2 bit  ST Stop bit  TD0, TD1 Timer frequency bits  TE Timer enable bit  Timer flag	OUT	Output level
RB0-RB2  RPT11-RPT15  Alarm 1 repeat mode bits  RPT21-RPT25  Alarm 2 repeat mode bits  RS0-RS3  SQW frequency  SQWE  Square wave enable  SRAM/ALM2  SRAM/ALM2  Stop bit  TD0, TD1  Timer frequency bits  TE  Timer enable bit  Timer flag	OFIE	Oscillator fail interrupt enable
RPT11-RPT15 Alarm 1 repeat mode bits  RPT21-RPT25 Alarm 2 repeat mode bits  RS0-RS3 SQW frequency  SQWE Square wave enable  SRAM/ALM2 SRAM/alarm 2 bit  ST Stop bit  TD0, TD1 Timer frequency bits  TE Timer enable bit  TF Timer flag	ОТР	OTP control bit
RPT21-RPT25  RS0-RS3  SQW frequency  SQWE  Square wave enable  SRAM/ALM2  SRAM/alarm 2 bit  ST  Stop bit  TD0, TD1  Timer frequency bits  TE  Timer enable bit  TF  Timer flag	RB0-RB2	Watchdog resolution bits
RS0-RS3 SQW frequency SQWE Square wave enable SRAM/ALM2 SRAM/alarm 2 bit ST Stop bit TD0, TD1 Timer frequency bits TE Timer enable bit TF Timer flag	RPT11-RPT15	Alarm 1 repeat mode bits
SQWE Square wave enable  SRAM/ALM2 SRAM/alarm 2 bit  ST Stop bit  TD0, TD1 Timer frequency bits  TE Timer enable bit  TF Timer flag	RPT21-RPT25	Alarm 2 repeat mode bits
SRAM/ALM2 SRAM/alarm 2 bit ST Stop bit TD0, TD1 Timer frequency bits TE Timer enable bit TF Timer flag	RS0-RS3	SQW frequency
ST Stop bit  TD0, TD1 Timer frequency bits  TE Timer enable bit  TF Timer flag	SQWE	Square wave enable
TD0, TD1 Timer frequency bits  TE Timer enable bit  TF Timer flag	SRAM/ALM2	SRAM/alarm 2 bit
TE Timer enable bit TF Timer flag	ST	Stop bit
TF Timer flag	TD0, TD1	Timer frequency bits
	TE	Timer enable bit
TI/TP Timer interrupt or pulse	TF	Timer flag
	TI/TP	Timer interrupt or pulse
TIE Timer interrupt enable	TIE	Timer interrupt enable
WDF Watchdog flag	WDF	Watchdog flag

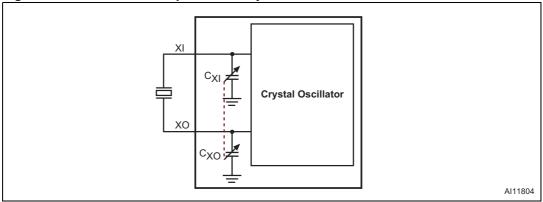
### 3.3 Real-time clock accuracy

The M41T8x is driven by a quartz controlled oscillator with a nominal frequency of 32,768 Hz. The accuracy of the real-time clock is dependent upon the accuracy of the crystal, and the match between the capacitive load of the oscillator circuit and the capacitive load for which the crystal was trimmed. Temperature also affects the crystal frequency, causing additional error (see *Figure 17 on page 30*).

The M41T8x provides the option of clock correction through either manufacturing calibration or in-application calibration. The total possible compensation is typically –93 ppm to +156 ppm. The two compensation circuits that are available are:

- An analog calibration register (12h) can be used to adjust internal (on-chip) load capacitors for oscillator capacitance trimming. The individual load capacitors C<sub>XI</sub> and C<sub>XO</sub> (see *Figure 16*), are selectable from a range of –18 pF to +9.75 pF in steps of 0.25 pF. This translates to a calculated compensation of approximately ±30 ppm (see *Section 3.4.2: Analog calibration (programmable load capacitance) on page 29*).
- 2. A digital calibration register (08h) can also be used to adjust the clock counter by adding or subtracting a pulse at the 512 Hz divider stage. This approach provides periodic compensation of approximately –63 ppm to +126 ppm (see Section 3.4.1: Digital calibration (periodic counter correction) on page 26).

Figure 16. Internal load capacitance adjustment



### 3.4 Clock calibration

The M41T8x oscillator is designed for use with a 12.5 pF crystal load capacitance. When the calibration circuit is properly employed, accuracy improves to better than  $\pm 1$  ppm at 25 °C.

The M41T8x design provides the following two methods for clock error correction.

### 3.4.1 Digital calibration (periodic counter correction)

This method employs the use of periodic counter correction by adjusting the ratio of the 100 Hz divider stage to the 512 Hz divider stage. Under normal operation, the 100 Hz divider stage outputs precisely 100 pulses for every 512 pulses of the 512 Hz input stage to provide the input frequency to the fraction of seconds clock register. By adjusting the number of 512 Hz input pulses used to generate 100 output pulses, the clock can be sped up or slowed down, as shown in *Figure 19 on page 32*.

When a non-zero value is loaded into the five calibration bits (DC4 – DC0) found in the digital calibration register (08h) and the sign bit is 1, (indicating positive calibration), the 100 Hz stage outputs 100 pulses for every 511 input pulses instead of the normal 512. Since the 100 pulses are now being output in a shorter window, this has the effect of speeding up the clock by 1/512 seconds for each second the circuit is active. Similarly, when the sign bit is 0, indicating negative calibration, the block outputs 100 pulses for every 513 input pulses. Since the 100 pulses are then being output in a longer window, this has the effect of slowing down the clock by 1/512 seconds for each second the circuit is active.

The amount of calibration is controlled by using the value in the calibration register (N) to generate the adjustment in one second increments. This is done for the first N seconds once every *eight* minutes for positive calibration, and for N seconds once every *sixteen* minutes for negative calibration (see *Table 6 on page 28*).

For example, if the calibration register is set to 100010, then the adjustment will occur for two seconds in every minute. Similarly, if the calibration register is set to 000011, then the adjustment will occur for 3 seconds in every alternating minute.

The digital calibration bits (DC4 - DC0) occupy the five lower order bits in the digital calibration register (08h). These bits can be set to represent any value between 0 and 31 in binary form. The sixth bit (DCS) is a sign bit; 1 indicates positive calibration, 0 indicates negative calibration. Calibration occurs within an 8-minute (positive) or 16-minute (negative) cycle. Therefore, each calibration step has an effect on clock accuracy of +4.068 or -2.034 ppm. Assuming that the oscillator is running at exactly 32,768 Hz, each of the 31 increments in the calibration byte would represent +10.7 or -5.35 seconds per month, which corresponds to a total range of +5.5 or -2.75 minutes per month.

One method of determining the amount of digital calibration required is to use the frequency test output (FT) of the device (see *Section 3.14: IRQ1/FT/OUT pin, frequency test, interrupts and the OUT bit (M41T83 only) on page 41* for more information on enabling the FT output).

When FT is enabled, a 512 Hz signal is output in the IRQ1/FT/OUT pin on the M41T83, and on the FT/RST pin on the M41T82. This signal can be measured using a highly accurate timing device such as a frequency counter. The measured value is then compared to 512 Hz and the oscillator error in ppm is then determined.

The user should keep in mind that changes in the digital calibration value will not affect the signal measured on the FT pin. While the analog calibration circuit does affect the oscillator,

the digital calibration circuitry uses periodic counter correction which occurs downstream of the 512 Hz divider chain and hence has no effect on the FT pin.

Note: 1 The modified pulses are not observable on the frequency test (FT) output, nor will the effect of the calibration be measurable real-time, due to the periodic nature of the error compensation.

2 Positive digital calibration is performed on an eight minute cycle, therefore the value in the calibration register should not be modified more frequently than once every eight minutes for positive values of calibration. Negative digital calibration is performed on a sixteen minute cycle, therefore negative values in the calibration register should not be modified more frequently than once every sixteen minutes.

Table 6. Digital calibration values

Calibration value (binary)	Calibration value rounded to the nearest ppm							
DC4 - DC0	Negative calibration (DCS = 0) to slow a fast clock	Positive calibration (DCS = 1) to speed up a slow clock						
0 (00000)	0	0						
1 (00001)	-2	4						
2 (00010)	-4	8						
3 (00011)	-6	12						
4 (00100)	-8	16						
5 (00101)	-10	20						
6 (00110)	-12	24						
7 (00111)	-14	28						
8 (01000)	-16	33						
9 (01001)	-18	37						
10 (01010)	-20	41						
11 (01011)	-22	45						
12 (01100)	-24	49						
13 (01101)	-26	53						
14 (01110)	-28	57						
15 (01111)	-31	61						
16 (10000)	-33	65						
17 (10001)	-35	69						
18 (10010)	-37	73						
19 (10011)	-39	77						
20 (10100)	-41	81						
21 (10101)	-43	85						
22 (10110)	-45	90						
23 (10111)	-47	94						
24 (11000)	-49	98						
25 (11001)	-51	102						
26 (11010)	-53	106						
27 (11011)	<b>-</b> 55	110						
28 (11100)	<b>–</b> 57	114						
29 (11101)	-59	118						
30 (11110)	-61	122						
31 (11111)	-63	126						
N	N/491520 (per minute)	N/245760 (per minute)						

### 3.4.2 Analog calibration (programmable load capacitance)

A second method of calibration employs the use of programmable internal load capacitors to adjust (or trim) the oscillator frequency. As discussed in *Section 3.4.1*, the 512 Hz frequency test output can be used to determine the amount of frequency error in the oscillator. Changes in the analog calibration value will affect the frequency test output, thus the user can immediately see the effects of these changes (see *Section 3.14 on page 41* for more information on enabling the FT output).

By design, the oscillator is intended to be 0 ppm ± crystal accuracy at room temperature (25 °C, see *Figure 17 on page 30*). For a 12.5 pF crystal, the default loading on each side of the crystal will be 25 pF. For incrementing or decrementing the calibration value, capacitance will be added or removed in increments of 0.25 pF to each side of the crystal.

Internally,  $C_{LOAD}$  of the oscillator is changed via two digitally controlled capacitors,  $C_{XI}$  and  $C_{XO}$ , connected from the XI and XO pins to ground (see *Figure 16 on page 25*). The effective on-chip series load capacitance,  $C_{LOAD}$ , ranges from 3.5 pF to 17.4 pF, with a nominal value of 12.5 pF (AC0 – AC6 = 0).

The effective series load capacitance ( $C_{LOAD}$ ) is the combination of  $C_{XI}$  and  $C_{XO}$ :

$$C_{LOAD} = 1/(1/C_{XI} + 1/C_{XO})$$

Seven analog calibration bits, AC0 to AC6, are provided in order to adjust the on-chip load capacitance value for frequency compensation of the RTC. Each bit has a different weight for capacitance adjustment. An analog calibration sign (ACS) bit determines if capacitance is added (ACS bit = 0, negative calibration) or removed (ACS bit = 1, positive calibration). The majority of the calibration adjustment is positive (i.e. to increase the oscillator frequency by removing capacitance) due to the typical characteristic of quartz crystals to slow down due to changes in temperature, but negative calibration is also available.

Since the analog calibration register adjustment is essentially pulling the frequency of the oscillator, the resulting frequency changes will not be linear with incremental capacitance changes. The equations which govern this mechanism indicate that smaller capacitor values of analog calibration adjustment will provide larger increments. Thus, the larger values of analog calibration adjustment will produce smaller incremental frequency changes. These values typically vary from 6-10 ppm/bit at the low end to <1 ppm/bit at the highest capacitance settings. The range provided by the analog calibration register adjustment with a typical surface mount crystal is approximately  $\pm 30$  ppm around the AC6-AC0 = 0 default setting because of this property (see *Table 7 on page 30*).

#### Pre-programmed calibration value

Users of the M41T83 in the embedded crystal package have the option of using the factory programmed analog calibration value (refer to *Section 3.17: OTP bit operation (M41T83 in SOX18 package only) on page 45*).

Frequency (ppm) 20 0 -20 -40 -60  $\frac{\Delta F}{F} = K \times (T - T_0)^2$ -80  $K = -0.036 \text{ ppm/}^{\circ}\text{C}^2 \pm 0.006 \text{ ppm/}^{\circ}\text{C}^2$ -100  $T_O = 25^{\circ}C \pm 5^{\circ}C$ -120 -140 -160 -40 -30 -20 20 30 50 70 80 Temperature °C AI07888

Figure 17. Crystal accuracy across temperature

Table 7. Analog calibration values

calib	Analog calibration value	D7	D6	D5	D4	D3	D2	D1	D0	C <sub>XI</sub> , C <sub>XO</sub>	C <sub>LOAD</sub> <sup>(1)</sup>
		ACS (±)	AC6 (16 pF)	AC5 (8 pF)	AC4 (4 pF)	AC3 (2 pF)	AC2 (1 pF)	AC1 (0.5 pF)	AC0 (0.25 pF)		½(C <sub>XI</sub> , C <sub>XO</sub> )
	0 pF	Х	0	0	0	0	0	0	0	25 pF	12.5 pF
	3 pF	0	0	0	0	1	1	0	0	28 pF	14 pF
12h	5 pF	0	0	0	1	0	1	0	0	30 pF	15 pF
1211	−7 pF	1	0	0	1	1	1	0	0	18 pF	9 pF
	9.75 pF <sup>(2)</sup>	0	0	1	0	0	1	1	1	34.75 pF	17.4 pF
	-18 pF <sup>(3)</sup>	1	1	0	0	1	0	0	0	7 pF	3.5 pF

<sup>1.</sup>  $C_{LOAD} = 1/(1/C_{XI} + 1/C_{XO})$ .

<sup>2.</sup> Maximum negative calibration value.

<sup>3.</sup> Maximum positive calibration value.

The on-chip capacitance can be calculated as follows:

$$C_{LOAD} = \frac{1}{2} [ACS (AC6: AC0 \text{ value, decimal}) \cdot 0.25 + 25] pF$$

where ACS is the sign.

For example:

- $C_{LOAD}$  (12h = x0000000) = 12.5 pF
- C<sub>LOAD</sub> (12h =11001000) = 3.5 pF (sign is negative)
- C<sub>LOAD</sub> (12h = 00100111) = 17.4 pF

With the analog calibration adjusted to its lowest value, the oscillator will see a minimum of 3.5 pF load capacitance as shown on the bottom row of *Table 7*.

Note:

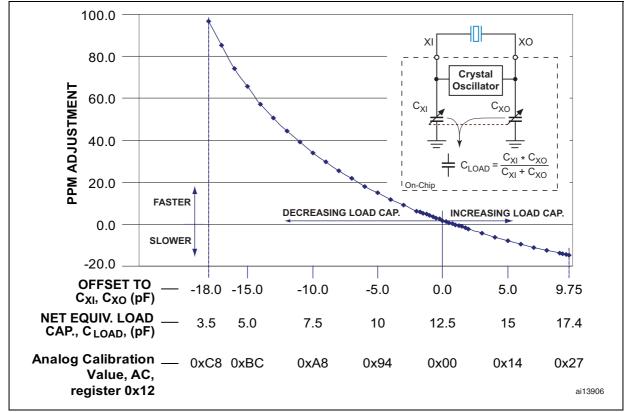
These are typical values, and the total load capacitance seen by the crystal will include approximately 1-2 pF of package and board capacitance in addition to the analog calibration register value.

Any invalid value of analog calibration will result in the default capacitance of 25 pF.

The combination of analog and digital trimming can give up to –93 to +156 ppm of the total adjustment.

Figure 18 represents a typical curve of clock ppm adjustment versus the analog calibration value. This curve may vary with different crystals, so it is good practice to evaluate the crystal to be used with an M41T8x device before establishing the adjustment values for the application in question.

Figure 18. Clock accuracy vs. on-chip load capacitance



Two methods are available for ascertaining how much calibration a given M41T8x may require:

The first involves setting the clock, letting it run for a month and comparing it to a known accurate reference and recording deviation over a fixed period of time. This allows the designer to give the end user the ability to calibrate the clock as the environment requires, even if the final product is packaged in a non-user serviceable enclosure. The designer could provide a simple utility that accesses either or both of the calibration bytes.

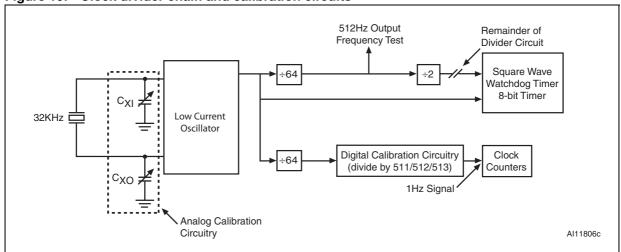
• The second approach is better suited to a manufacturing environment, and uses the 512 Hz frequency test output. This is the IRQ1/FT/OUT pin on the M41T83, and the FT/RST pin on the M41T82 (see Section 3.14 and Section 3.15 for more information on enabling the FT output). The 512 Hz frequency test signal can be measured using a highly accurate timing device such as a frequency counter. The measured value is then compared to 512 Hz and the oscillator error in ppm is then determined.

Any deviation from 512 Hz indicates the degree and direction of oscillator frequency shift at the test temperature. For example, a reading of 512.010124 Hz would indicate a  $\pm$ 20 ppm oscillator frequency error, requiring either a  $\pm$ 10 (xx001010) to be loaded into the digital calibration byte, or  $\pm$ 6 pF (00011000) into the analog calibration byte for correction.

Note:

Setting or changing the digital calibration byte does not affect the frequency test, square wave, or watchdog timer frequency, but changing the analog calibration byte DOES affect all functions derived from the low current oscillator (see Figure 19).





Crystal
Local Grounding
Plane (Layer 2)

XI XO

Figure 20. Crystal isolation example

Substrate pad should be tied to V<sub>SS</sub>.

### 3.5 Setting the alarm clock registers

Codes not listed in the table default to the once-per-second mode to quickly alert the user of an incorrect alarm setting. When the clock information matches the alarm clock settings based on the match criteria defined by RPTx5–RPTx1 (x = 1 for alarm 1 or 2 for alarm 2), the alarm flag, AFx, is set. Reading the flags register clears the alarm flags. A subsequent read of the flags register is necessary to see that the value of the alarm flag has been reset to 0.

#### M41T83 interrupts on alarm

In the M41T83, for alarm 1, setting the alarm interrupt enable, A1IE, allows an interrupt output to be asserted upon AF1 being set provided that other configuration bits are set accordingly (see *Section 3.14* for more information on the IRQ/FT/OUT output).

Likewise for alarm 2, with A2IE set,  $\overline{IRQ2}$  will be asserted upon AF2 going high. To disable either of the alarms, write a 0 to the alarm date registers and to the RPTx5–RPTx1 bits.

Note:

If the address pointer is allowed to increment to the flag register address, or the last address written is "Alarm Seconds," the address pointer will increment to the flag address, and an alarm condition will not cause the interrupt/flag to occur until the address pointer is moved to a different address.

Alarm IRQ outputs are de-asserted when the alarm flags are cleared by reading the flags register (0Fh).

The  $\overline{IRQ1}/FT/OUT$  pin can also be activated in the battery backup mode. This requires the ABE bit (alarm in backup enable) to be set (see *Section 3.14.2: Backup mode* for additional conditions which apply). Once an interrupt is asserted in backup mode, it will remain true until  $V_{CC}$  is restored and a subsequent read of the flags register occurs.

AI11814

### 3.6 Optional second programmable alarm and user SRAM

When the alarm 2 enable (AL2E) bit (D1 of address 13h) is set to a logic 1, registers 14h through 18h provide control for a second programmable alarm which operates in the same manner as the alarm function described in *Section 3.5*. The AL2E bit defaults on initial power-up to a logic 0 (alarm 2 disabled). In this mode, the five alarm 2 bytes (14h-18h) function as additional user SRAM, for a total of 12 bytes of user SRAM.

With AL2E set to 1, the alarm is enabled, and will cause the AF2 bit to be set when the alarm condition is met. On the M41T83, if the A2IE (alarm 2 interrupt enable) bit is set, an interrupt will be asserted on IRQ2. The interrupt is de-asserted when the alarm flags are cleared by reading the flags register (0Fh).

IRQ2 can be enabled in backup mode by setting ABE to 1 (in conjuction with setting A2IE).

	,	opout			
RPT5	RPT4	RPT3	RPT2	RPT1	Alarm setting
1	1	1	1	1	Once per second
1	1	1	1	0	Once per minute
1	1	1	0	0	Once per hour
1	1	0	0	0	Once per day
1	0	0	0	0	Once per month
0	0	0	0	0	Once per year

Table 8. Alarm repeat modes

### 3.7 Watchdog timer

The watchdog timer can be used to detect an out-of-control microprocessor. The user programs the watchdog timer by setting the desired amount of time-out into the watchdog register, address 09h. Bits BMB4-BMB0 store a binary multiplier and the two lower order bits RB1-RB0 select the resolution, where 00 = 1/16 second, 01 = 1/4 second, 10 = 1 second, and 11 = 4 seconds. The amount of time-out is then determined to be the multiplication of the five-bit multiplier value with the resolution. (For example: writing 00001110 in the watchdog register = 3\*1, or 3 seconds). If the processor does not reset the timer within the specified period, the M41T8x sets the WDF (watchdog flag).

The watchdog timer is reset by writing to the watchdog register. The time-out period then starts over.

#### M41T83 watchdog interrupt

On the M41T83, provided that the necessary configuration bits are set, the  $\overline{\text{IRQ}}/\text{FT/OUT}$  output will be asserted when the watchdog times out (see *Section 3.14* for additional conditions which apply).

Should the watchdog time out, to de-assert the IRQ1/FT/OUT output, the lower seven bits of the watchdog register (09h) must be written. This will de-assert the output and re-initialize the watchdog. Writing these seven bits to 0 will de-assert the output and disable the watchdog.

A READ of the flags register will reset the watchdog flag (bit D7; register 0Fh) but not deassert the  $\overline{\text{IRQ1/FT/OUT}}$  output. The watchdog function is automatically disabled upon power-up and the watchdog register is cleared.

Table 9. Watchdog register

Addr	D7	D6	D5	D4	D3	D2	D1	D0	Function
09h	OFIE	BMB4	BMB3	BMB2	BMB1	BMB0	RB1	RB0	Watchdog

### 3.8 8-bit (countdown) timer

The timer value register is an 8-bit binary countdown timer. It is enabled and disabled via the timer control register (11h) TE bit. Other timer properties such as the source clock, or interrupt generation are also selected in the timer control register (see *Table 10*). For accurate read back of the countdown value, the I<sup>2</sup>C-bus clock (SCL) must be operating at a frequency of at least twice the selected timer clock.

The timer control register selects one of four source clock frequencies for the timer (4096, 64, 1, or 1/60 Hz), and enables/disables the timer. The timer counts down from a software-loaded 8-bit binary value (register 10h) and decrements to 1. On the next tick of the counter, it reloads the timer countdown value and sets the timer flag (TF) bit. The TF bit can only be cleared by software. When asserted, the timer flag (TF) can also be used to generate an interrupt ( $\overline{IRQ1}/FT/OUT$ ) on the M41T83. Writing the timer countdown value (10h) has no effect on the TF bit or the  $\overline{IRQ1}/FT/OUT$  output.

### 3.8.1 M41T83 timer interrupt/output

On the M41T83, there are two choices for the output depending on the  $\overline{\text{TI}}/\text{TP}$  configuration bit (timer interrupt/timer pulse, bit 6, register 11h).

#### Normal interrupt mode

With  $\overline{\text{TI}}/\text{TP} = 0$ , the output will assert like a normal interrupt, staying low until the TF bit is cleared by software by reading the flags register (0Fh).

#### Free-running mode

When TI/TP is a 1, the output is a free-running waveform as depicted in *Figure 21*. After being low for the specified time (as shown in *Table 11*), the output automatically goes high without need of software clearing any bits. The TF bit will still be set each time the timer reloads, but it is not necessary for the software to clear it in this mode. Furthermore, clearing the TF bit has no effect on the output in this mode.

While writes to the timer countdown register (10h) control the reload value, reads of this register return the current countdown timer value.

Table 10. Timer control register map <sup>(1)</sup>
---

Addr	D7	D6	<b>D</b> 5	D4	D3	D2	D1	D0	Function
0Fh	WDF	AF1	AF2	BL	TF	OF	0	0	Flags
10h	Timer countdown value <sup>(2)</sup>								Timer value
11h	TE	TI/TP	TIE	0	0	0	TD1	TD0	Timer control

- 1. Bit positions labeled with 0 should always be written with logic 0.
- 2. Writing to the timer register will not reset the TF bit nor clear the interrupt.

When the timer is in the free-running mode, with a value of n programmed into the timer countdown value, the output will nominally be low for one cycle of the specified clock source and high for n-1 cycles with an overal period of n cycles. Thus, the countdown period is n/source clock frequency.

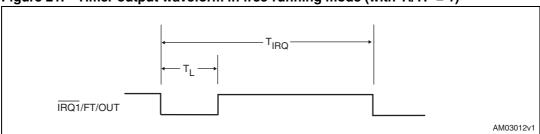
For the special case of n = 1, as shown in *Table 11*, when the clock source is 4096 or 64 Hz, the low time  $(T_1)$  is half the clock period instead of a full clock period.

Table 11. Timer interrupt operation in free-running mode (with  $\overline{TI}/TP = 1$ )

Source clock (Hz)	IRQ low time –	T <sub>L</sub> (seconds) <sup>(1)</sup>	IRQ period – T <sub>IRQ</sub> (seconds)		
Source clock (Hz)	n = 1 <sup>(2)</sup>	n > 1	n = 1	n > 1	
4096	1/8192 = 122 µs	1/4096 = 244 µs	1/4096 = 244 µs	n / 4096	
64	1/128 = 7.8 ms	1/64 = 15.6 ms	1/64 = 15.6 ms	n / 64	
1	1/64	1/64	1	n	
1/60	1/64	1/64	1 minute	n minutes	

- 1. IRQ1/FT/OUT is asserted coincident with TF going true.
- 2. n = loaded countdown timer value (0 < n < 255). The timer is stopped when n = 0.

Figure 21. Timer output waveform in free-running mode (with  $\overline{TI}/TP = 1$ )



#### 3.8.2 Timer flag (TF)

At the end of a timer countdown, when the timer reloads, TF is set to logic '1.' Regardless of the state of TF bit (or  $\overline{TI}/TP$  bit), the timer will continue decrementing and reloading.

If both timer and alarm interrupts are used in the application, the source of the interrupt can be determined by reading the flag bits. Refer to *Section 3.14* for more information on the interaction of these bits. The TF bit is cleared by reading the flags register. This will deassert an interrupt output due to the timer.

#### 3.8.3 Timer interrupt enable (TIE, M41T83 only)

In normal interrupt mode ( $\overline{\text{TI}}/\text{TP} = 0$ ), when TF is asserted, the interrupt output is asserted (if TIE = 1). To de-assert the interrupt, the TF bit or the TIE bit must be reset. Disabling the interrupt by clearing the TIE bit will de-assert the output, but does not clear the TF bit. Thus, if TIE is re-enabled prior to clearing TF, the interrupt will assert immediately.

#### 3.8.4 Timer enable (TE)

● TE = 0

When the timer register (10h) is set to 0, the timer is disabled.

● TE = 1

The timer is enabled. TE is reset (disabled) on power-down. When re-enabled, the counter will begin counting from the same value as when it was disabled.

#### 3.8.5 TD1/0

These are the timer source clock frequency selection bits (see *Table 12*). These bits determine the source clock for the countdown timer (see *Table 10 on page 36*). When not in use, the TD1 and TD0 bits should be set to 11 (1/60 Hz) for power saving.

		, ,
TD1	TD0	Timer source clock frequency (Hz)
0	0	4096 (244.1 μs)
0	1	64 (15.6 ms)
1	0	1 (1 s)
1	1	1/60 (60 s)

Table 12. Timer source clock frequency selection (244.1 µs to 4.25 hrs)

## 3.9 Square wave output (M41T83 only)

The M41T83 offers the user a programmable square wave function which is output on the SQW pin. RS3-RS0 bits located in 13h establish the square wave output frequency. These frequencies are listed in *Table 13*. Once the selection of the SQW frequency has been completed, the SQW pin can be turned on and off under software control with the square wave enable bit (SQWE) located in register 0Ah.

Note:

If the SQWE bit is set to '1' and  $V_{CC}$  falls below the switchover ( $V_{SO}$ ) voltage, the square wave output will be disabled.

Table 13. Square wave output frequency

	Square v	vave bits		Square	e wave
RS3	RS2	RS1	RS0	Frequency	Units
0	0	0	0	None	_
0	0	0	1	32.768	kHz
0	0	1	0	8.192	kHz
0	0	1	1	4.096	kHz
0	1	0	0	2.048	kHz
0	1	0	1	1.024	kHz
0	1	1	0	512	Hz
0	1	1	1	256	Hz
1	0	0	0	128	Hz
1	0	0	1	64	Hz
1	0	1	0	32	Hz
1	0	1	1	16	Hz
1	1	0	0	8	Hz
1	1	0	1	4	Hz
1	1	1	0	2	Hz
1	1	1	1	1	Hz

### 3.10 Battery low warning

The M41T8x automatically checks the battery each time V<sub>CC</sub> powers up and each time the clock rolls over at midnight.

 $V_{BAT}$  is compared to  $V_{BL}$  (approximately 2.5 V), then the battery low (BL) bit, D4 of flags register 0Fh, is set if the battery voltage is found to be less than  $V_{BL}$ . Similarly, if  $V_{BAT}$  is greater than  $V_{BL}$ , the BL bit is cleared during battery check.

The BL bit retains its state until the next battery check occurs. This means the BL bit will not clear immediately upon battery replacement, but only after the next battery check occurs at the next power-up or midnight rollover.

If a battery low is generated during a power-up sequence, this indicates that the battery is below approximately 2.5 volts and may not be able to maintain data integrity. Clock data should be considered suspect and verified as correct. A fresh battery should be installed.

If a battery low indication is generated during the 24-hour interval check, this indicates that the battery is near end of life. However, data is not compromised due to the fact that a nominal  $V_{CC}$  is supplied. In order to ensure data integrity during subsequent periods of battery backup mode, the battery should be replaced.

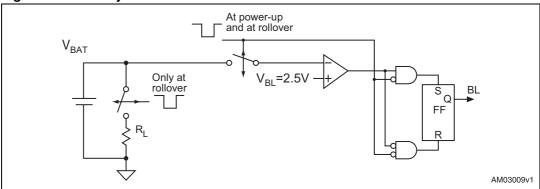
#### Midnight rollover check

As shown in *Figure 22*, during the midnight rollover check, the M41T8x applies a load to the battery, then compares  $V_{BAT}$  to  $V_{BL}$  and updates the BL bit accordingly. Because a load is present, an open condition on the  $V_{BAT}$  pin will result in the BL bit being set. After the check is performed, the RTC removes the load.

#### Power-up battery check

During the power-up check, no load is applied to the battery under the assumption the battery has already been stressed to its working level by having powered the RTC in backup mode. If no battery is present,  $V_{BAT}$  will be floating and the battery check result will be indeterminate.

Figure 22. Battery check



The M41T8x only checks the battery when powered by  $V_{CC}$ . It does not check the battery while in backup mode. Thus, users are advised that during long periods in backup mode, the battery can drop to a level at which timekeeping may fail or data becomes corrupted. If, at power-up, a battery low is indicated, data integrity should be verified.

#### Forcing a battery check

If it is desired to check the battery at an arbitrary time, one common technique is for the application software to write the time to just before midnight, 23:59:59, and then wait two seconds thereby letting the clock rollover and causing the BL bit to update. The application then restores the time back to its previous value plus two seconds.

# 3.11 Century bits

These two bits will increment in a binary fashion at the turn of the century, and handle all leap years correctly. See *Table 14* for additional explanation.

Table 14. Ochtary i	ons examples		
СВ0	CB1	Leap Year?	Example <sup>(1)</sup>
0	0	Yes	2000
0	1	No	2100
1	0	No	2200
1	1	No	2300

Table 14. Century bits examples

#### 3.12 Oscillator fail detection

If the oscillator fail (OF) bit is internally set to a '1,' this indicates that the oscillator has either stopped, or was stopped for some period of time. This bit can be used to judge the validity of the clock and date data. This bit will be set to '1' any time the oscillator stops.

In the event the OF bit is found to be set to '1' at any time other than the initial power-up, the STOP bit (ST) should be written to a '1,' then immediately reset to 0. This will restart the oscillator. The following conditions can cause the OF bit to be set:

The first time power is applied (defaults to a '1' on power-up).

Note:

If the OF bit cannot be written to '0' four seconds after the initial power-up, the STOP bit (ST) should be written to a '1,' then immediately reset to 0.

- The voltage present on V<sub>CC</sub> or battery is insufficient to support oscillation.
- The ST bit is set to '1.'
- External interference of the crystal

For the M41T83, if the oscillator fail interrupt enable bit (OFIE) is set to a '1,' the  $\overline{IRQ1}/FT/OUT$  pin will also be asserted (see Section 3.13 and Section 3.14 for additional conditions which apply). The  $\overline{IRQ1}/FT/OUT$  output is de-asserted by resetting the OF bit to 0, NOT by reading the flags register. The OF bit will remain a '1' until written to 0. Reading the flags register has no effect on OF.

Leap year occurs every four years (for years evenly divisible by four), except for years evenly divisible by 100. The only exceptions are those years evenly divisible by 400 (the year 2000 was a leap year, year 2100 is not).

The oscillator must start and have run for at least 4 seconds before attempting to reset the OF bit to 0.

The oscillator fail detect circuit funtions during backup mode. If a triggering event occurs to disrupt the oscillator during a power-down condition, the OF bit will be set accordingly.

### 3.13 Oscillator fail interrupt enable (M41T83 only)

With the OFIE bit set, the OF bit will cause the IRQ1/FT/OUT output to be asserted (see Section 3.14.1 and 3.14.2 for additional conditions that apply). The IRQ1/FT/OUT output is cleared by resetting the OF bit to 0 (NOT by reading the flags register). Clearing the OFIE bit will also cause the IRQ1/FT/OUT output to de-assert, but if OFIE is subsequently set prior to clearing OF, the IRQ1/FT/OUT output will assert immediately upon setting OFIE. Clearing the OF bit is necessary to prevent such an inadvertent interrupt.

If the alarm in backup enable bit, ABE, is set (along with OFIE), the oscillator fail detect will cause an interrupt in the  $\overline{\text{IRQ1}}/\text{FT/OUT}$  pin during backup mode. For additional information on this, refer to *Section 3.14.2*.

# 3.14 IRQ1/FT/OUT pin, frequency test, interrupts and the OUT bit (M41T83 only)

Four interrupt sources, the frequency test function, and the discrete output bit OUT all share the  $\overline{IRQ1}/FT/OUT$  pin. Priority is built into the part such that some functions dominate others. Additionally, the priority depends on configuration bits such as OUT and ABE, and on whether the part is operating on  $V_{CC}$  or is in the backup mode. This pin is an open drain output and requires an external pull-up resistor.

Figure 23 shows the various signal sources and controlling bits for the IRQ1/FT/OUT output pin.

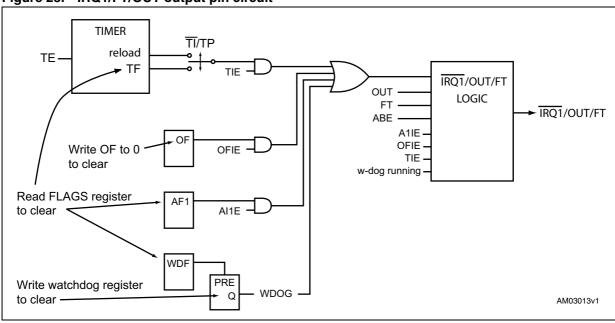


Figure 23. IRQ1/FT/OUT output pin circuit

The timer, oscillator fail detect circuit, alarm 1, and watchdog are ORed together as the primary interrupt sources. The frequency test signal, FT, is used to enable a 512 Hz output on the  $\overline{\text{IRQ1}}/\text{FT/OUT}$  pin for calibrating the RTC. When not used as an interrupt or frequency test output, the pin can be used as a discrete logic output controlled by the OUT bit. The ABE bit is used to enable interrupts during backup mode.

Operating on  $V_{CC}$ , all four interrupt sources are available. During backup, the timer and watchdog are disabled, and the only interrupt sources are alarm 1 and the oscillator fail detect circuit.

#### 3.14.1 Active mode operation on V<sub>CC</sub>

On V<sub>CC</sub>, the operation of the output circuit is as shown in *Table 15*.

Table 15. Priority for IRQ1/FT/OUT pin when operating on V<sub>CC</sub>

OUT <sup>(1)</sup>	FT <sup>(2)</sup>	A1IE <sup>(3)</sup> + OFIE <sup>(4)</sup> + TIE <sup>(5)</sup> + watchdog <sup>(6)</sup> running	Pin	Comment
0	0	x	0	When OUT is 0 and FT is not enabled, OUT dominates and none of the interrupt sources have any effect.
0	1	Х	512 Hz	When FT = 1 and OUT = 1 and no interrupts are enabled,
х	1	0	312112	the output will be the 512 Hz frequency test (FT) signal.
1	x	1	ĪRQ	When one or more interrupts are enabled, and OUT is a 1, the pin stays high until one of the interrupts is asserted.
1	0	0	1	When OUT is 1, FT is 0 and no interrupts are enabled, the pin is high.

- 1. OUT is bit 7 of register 08h (digital calibration).
- 2. FT is bit 6 of register 08h (digital calibration).
- 3. A1IE is bit 7 of register 0Ah (alarm 1, month).
- 4. OFIE is bit 7 of register 09h (watchdog).
- 5. TIE is bit 5 of register 11h (timer control).
- 6. The watchdog is controlled by register 09h (watchdog).

When OUT is 0 and FT is 0, the pin will be 0 regardless of whether any interrupts are enabled.

When FT is a 1, the 512 Hz signal will be output if OUT is 0 or if no interrupts are enabled.

The interrupt sources control the pin when OUT is 1 and one or more of the interrupts are enabled.

If OUT is 1, FT is 0 and no interrupts are enabled, then the pin will be 1.

#### 3.14.2 Backup mode

In backup mode, the operation of the output circuit is as shown in *Table 16*.

Table 16. Priority for IRQ1/FT/OUT pin when operating in backup mode

OUT <sup>(1)</sup>	ABE <sup>(2)</sup>	A1IE <sup>(3)</sup> + OFIE <sup>(4)</sup>	Pin	Comment
x	0	x	1	When ABE is 0, the pin is 1 regardless of OUT or the interrupt sources.
1	х	0	1	When OUT is 1 and no interrupts are enabled, the pin is 1. (A1IE and OFIE are the only interrupts applicable in this mode).
0	1	х	0	When ABE is 1 and OUT is 0, OUT dominates and regardless of the interrupt sources.
1	1	1	ĪRQ	When one or more interrupts are enabled, ABE is a 1, and OUT is a 1, the pin stays high until one of the interrupts is asserted.

- 1. OUT is bit 7 of register 08h (digital calibration).
- 2. ABE is bit 5 of register 0Ah (alarm 1, month).
- 3. A1IE is bit 7 of register 0Ah (alarm 1, month).
- 4. OFIE is bit 7 of register 09h (watchdog).

In backup mode, frequency test is disabled. Thus, the FT bit is a 'don't care'.

ABE enables interrupts in backup. If it is 0, the output pin is a 1 regardless of the other bits.

The pin is also a 1 when OUT is a 1 and no interrupts are enabled.

When OUT is 0 and ABE is a 1, the pin is 0 regardless of the interrupts.

Thus, in order to enable interrupts in backup mode, OUT must be a 1 and ABE must be a 1, and one or more of the interrupt enables must be a 1.

#### Simultaneous interrupts

Since more than one interrupt source can cause the  $\overline{\text{IRQ1}}/\text{FT/OUT}$  pin to go low, more than one interrupt may be pending when the microprocessor services the interrupt. Therefore, the application software should read the flags register (0Fh) to discern which condition or conditions are causing the pin to be asserted.

Also be aware that once a flag causes the pin to assert, other flags could subsequently also go true. Since the pin is already low due to the first, no additional output transition will occur. That is why the software must check the flags register.

Example: If the watchdog is in use and the oscillator fail detect interrupt is enabled, and the watchdog times out, the IRQ1/FT/OUT pin will go low. If, in the intervening time before the processor services the interrupt, something disturbs the oscillator, such as a drop of moisture landing on the crystal pins, the OF bit will also be set. Thus, when the software services the interrupt, it must service both sources: it must re-initialize the watchdog and clear the OF bit in order to de-assert the IRQ1/FT/OUT pin. By reading the flags register, the software will know both flags were set and that both need service.

# 3.15 FT/RST pin, frequency test and reset output pin (M41T82 only)

On the M41T82, the 512 Hz frequency test signal and the reset output share the same pin, FT/RST. When the FT bit (bit 6 of register 08h) is a 1, the 512 Hz test signal is activated on the pin. With FT a 0 and  $V_{CC}$  good (above  $V_{RST}$ ), the output will be high. If the 512 Hz is enabled when  $V_{CC}$  fails, the FT bit will be cleared and the output will go low to assert reset. At power-up, FT will be 0 leaving the pin functioning as the reset output.

## 3.16 Initial power-on defaults

Upon initial application of power to the device, the register bits will initially power-on in the state indicated in *Table 17* and *Table 18*.

Table 17. Initial power-on default values (part 1)

Condition <sup>(1)</sup>	ST	CB1	СВО	OUT	FT	DCS ACS	Digital calib.	Analog calib.	OFIE <sup>(2)</sup>	Watch- dog <sup>(3)</sup>	A1IE (2)	SQWE <sup>(2)</sup>	ABE
Initial power-up	0	0	0	1	0	0	0	0	0	0	0	1	0
Subsequent power-up <sup>(4)(5)</sup>	UC	UC	UC	UC	0	UC	UC	UC	UC	0	UC	UC	UC

- 1. All other control bits power-up in an undetermined state.
- 2. M41T83 only
- 3. BMB0-BMB4, RB0, RB1
- 4. With battery backup
- 5. UC = unchanged

Table 18. Initial power-up default values (part 2)

Condition <sup>(1)</sup>	RPT11 -15	нт	OF	TE	TI/TP (2)	TIE <sup>(2)</sup>	TD1	TD0	RS0	RS1-3	OTP (2)	A2IE <sup>(2)</sup>	RPT21- 25	AL2E
Initial power-up	0	1	1	0	0	0	1	1	1	0	0	0	0	0
Subsequent power-up <sup>(3)(4)</sup>	UC	1	UC	0	UC	UC	UC	UC	UC	UC	UC	UC	UC	UC

- 1. All other control bits power-up in an undetermined state.
- 2. M41T83 only
- 3. With battery backup
- 4. UC = unchanged

## 3.17 OTP bit operation (M41T83 in SOX18 package only)

When the OTP (one time programmable) bit is set to a '1,' the value in the internal OTP registers will be transferred to the analog calibration register (12h) and are "Read only." The OTP value is programmed by the manufacturer, and will contain the calibration value necessary to achieve  $\pm 5$  ppm at room temperature after two SMT reflows. This clock accuracy can then be guaranteed to drift no more than  $\pm 3$  ppm the first year, and  $\pm 1$  ppm for each following year due to crystal aging.

If the OTP bit is set to 0, the analog calibration register will become a WRITE/READ register and function like standard SRAM memory cells, allowing the user to implement any desired value of analog calibration.

When the user sets the OTP bit, they need to wait for approximately 8 ms before the analog registers transfer the value from the OTP to the analog registers due to the OTP read operation.

Maximum ratings M41T82-M41T83

# 4 Maximum ratings

Stressing the device above the rating listed in the absolute maximum ratings table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 19. Absolute maximum ratings

Sym	Parameter		Value <sup>(1)</sup>	Unit		
T <sub>STG</sub>	Storage temperature (V <sub>CC</sub> off, oscillator off)		-55 to 125	°C		
V <sub>CC</sub>	Supply voltage	-0.3 to 7.0	V			
		QFN16	260 <sup>(2)</sup>			
T <sub>SLD</sub>	Lead solder temperature for 10 seconds	SO8	200( /	°C		
		SOX18	240 <sup>(3)</sup>			
V <sub>IO</sub>	Input or output voltages		-0.2 to V <sub>CC</sub> +0.3	V		
Io	Output current		20	mA		
P <sub>D</sub>	Power dissipation		1	W		
		QFN16	35.7			
$\theta_{JA}$	Thermal resistance, junction to ambient	SO8	128.4	°C/W		
		SOX18				

<sup>1.</sup> Data based on characterization results, not tested in production.

<sup>2.</sup> Reflow at peak temperature of 260 °C. The time above 255 °C must not exceed 30 seconds.

<sup>3.</sup> Reflow at peak temperature of 240 °C. The time above 235 °C must not exceed 20 seconds.

# 5 DC and AC parameters

This section summarizes the operating and measurement conditions, as well as the dc and ac characteristics of the device. The parameters in the following DC and AC Characteristic tables are derived from tests performed under the measurement conditions listed in the relevant tables. Designers should check that the operating conditions in their projects match the measurement conditions when using the quoted parameters.

Table 20. Operating and AC measurement conditions

Parameter <sup>(1)</sup>	M41T8x
Supply voltage (V <sub>CC</sub> )	2.38 V to 5.5 V
Ambient operating temperature (T <sub>A</sub> )	−40 to 85 °C
Load capacitance (C <sub>L</sub> )	50 pF
Input rise and fall times	≤ 5 ns
Input pulse voltages	0.2 V <sub>CC</sub> to 0.8 V <sub>CC</sub>
Input and output timing ref. voltages	0.3 V <sub>CC</sub> to 0.7 V <sub>CC</sub>

<sup>1.</sup> Output Hi-Z is defined as the point where data is no longer driven.

Figure 24. Measurement AC I/O waveform

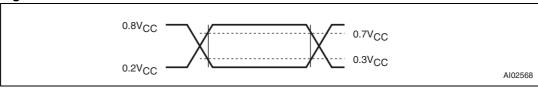


Table 21. Capacitance

Symbol	Parameter <sup>(1)(2)</sup>	Min	Max	Unit
C <sub>IN</sub>	Input capacitance		7	pF
C <sub>OUT</sub> <sup>(3)</sup>	Output capacitance		10	pF
t <sub>LP</sub>	Low-pass filter input time constant (SDA and SCL)		50	ns

- 1. Effective capacitance measured with power supply at 3.6 V; sampled only, not 100% tested.
- 2. At 25 °C, f = 1 MHz
- 3. Outputs deselected

Table 22. DC characteristics

Sym	Parameter	Test condition	on <sup>(1)</sup>	Min	Тур	Max	Unit
	Operating voltage (S)	−40 to 85 °C				5.50	V
$V_{CC}$	Operating voltage (R)	−40 to 85 °C				5.50	V
	Operating voltage (Z)	-40 to 85 °	2.38		5.50	V	
I <sub>LI</sub>	Input leakage current	0V ≤ V <sub>IN</sub> ≤ '	V <sub>CC</sub>			±1	μΑ
I <sub>LO</sub>	Output leakage current	0V ≤ V <sub>OUT</sub> ≤	V <sub>CC</sub>			±1	μΑ
		001 400111	5.5 V		125	150	μΑ
I <sub>CC1</sub>	Supply current	SCL = 400 kHz (No load)	3.0 V		55		μΑ
		(No load)	2.5 (Z only)		45		μΑ
		SCL = 0 Hz;	5.5 V		8	10	μΑ
I <sub>CC2</sub>	Supply current (standby)	All inputs $\ge$ V <sub>CC</sub> $-$ 0.2 V or $\le$ V <sub>SS</sub> + 0.2 V (SQWE bit = 0)	3.0 V		6.5		μА
V <sub>IL</sub>	Input low voltage		-0.3		0.3V <sub>CC</sub>	V	
V <sub>IH</sub>	Input high voltage			0.7V <sub>CC</sub>		V <sub>CC</sub> +0.3	V
		RST, FT/RST	$V_{CC}/V_{BAT} = 3.0 \text{ V},$ $I_{OL} = 1.0 \text{ mA}$			0.4	V
V <sub>OL</sub>	Output low voltage	SQW, IRQ1/FT/OUT, IRQ2	$V_{CC} = 3.0 \text{ V},$ $I_{OL} = 1.0 \text{ mA}$			0.4	V
		SCL, SDA	$V_{CC} = 3.0 \text{ V},$ $I_{OL} = 3.0 \text{ mA}$			0.4	V
V <sub>OH</sub>	Output high voltage	$V_{CC} = 3.0 \text{ V}, I_{OH} = -1.0$	mA (push-pull)	2.4			V
	Pull-up supply voltage (open drain)	IRQ1/FT/OUT, IRQ2,	FT/RST, RST			5.5	V
V <sub>BAT</sub>	Backup supply voltage (battery or capacitor)			2.0		5.5	V
V <sub>BL</sub>	Battery low (BL bit) threshold				2.5		٧
I <sub>BAT</sub>	Battery supply current	25 °C; V <sub>CC</sub> = 0 V; V <sub>BAT</sub> = 3 V; 32 I			365	450	nA

<sup>1.</sup> Valid for ambient operating temperature:  $T_A = -40$  to 85 °C;  $V_{CC} = 2.38$  V to 5.5 V (except where noted)

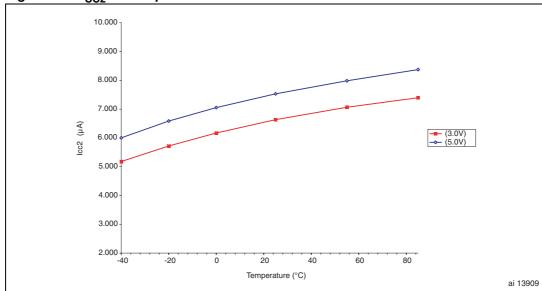


Figure 25. I<sub>CC2</sub> vs. temperature

Table 23. Crystal electrical characteristics

Symbol	Parameter <sup>(1)(2)</sup>	Min	Тур	Max	Units
f <sub>O</sub>	Resonant frequency		32.768		kHz
$R_S$	Series resistance			65 <sup>(3)</sup>	kΩ
C <sub>L</sub>	Load capacitance		12.5		pF

Externally supplied if using the QFN16 or SO8 package. STMicroelectronics recommends the Citizen CFS-145 (1.5 x 5 mm) and the KDS DT-38 (3 x 8 mm) for thru-hole, or the KDS DMX-26S (3.2 x 8 mm) or Micro Crystal MS3V-T1R (1.5 x 5 mm) for surface-mount, tuning fork-type quartz crystals. For contact information, see Section 8: References on page 59.

- 2. Load capacitors are integrated within the M41T8x. Circuit board layout considerations for the 32.768 kHz crystal of minimum trace lengths and isolation from RF generating signals should be taken into account.
- 3. Guaranteed by design.

Table 24. Oscillator characteristics

Symbol	Parameter <sup>(1)(2)</sup>	Conditions	Min	Тур	Max	Units
V <sub>STA</sub>	Oscillator start voltage	≤ 4 s	2.0			V
t <sub>STA</sub>	Oscillator start time	$V_{CC} = V_{SO}$			1	s
$C_{XI,} C_{XO}^{(1)}$	Capacitor input, capacitor output			25		pF
	IC-to-IC frequency variation <sup>(2)(3)</sup>		-10		+10	ppm

- 1. With default analog calibration value ( = 0)
- 2. Reference value
- 3.  $T_A = 25$  °C,  $V_{CC} = 5.0$  V

Figure 26. Power down/up mode AC waveforms

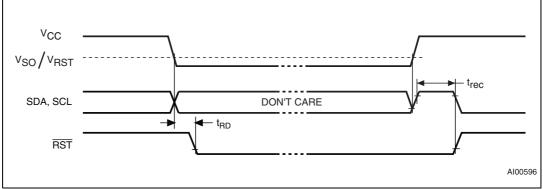


Table 25. Power down/up trip points DC characteristics

Sym	Parameter <sup>(1)(2)</sup>	Min	Тур	Max	Unit	
		S	2.85	2.93	3.0	V
V <sub>RST</sub>	Reset threshold voltage	R	2.55	2.63	2.7	٧
		2.25	2.32	2.38	V	
V	Battery backup switchover		V <sub>RST</sub>		V	
V <sub>SO</sub>	Hysteresis		25		mV	
t <sub>rec</sub>	RST duration after V <sub>CC</sub> high	140		280	ms	
t <sub>RD</sub>	V <sub>CC</sub> to reset delay <sup>(3)</sup>		2.5		μs	

<sup>1.</sup> All voltages referenced to  $V_{\mbox{\scriptsize SS}}$ 

<sup>2.</sup> Valid for ambient operating temperature:  $T_A = -40$  to 85 °C;  $V_{CC} = 2.38$  to 5.5 V (except where noted)

<sup>3.</sup> Measured with  $V_{CC}$  falling slew rate of 10 mV/ $\mu$ s for  $V_{CC}$  in the range  $V_{RST}$  + 100 mV to  $V_{RST}$  – 100 mV

SDA

tBUF

tHD:STA

tR

tF

tHD:STA

tHD:STA

tHO:STA

SCL

P

SSL

Al00589

Figure 27. Bus timing requirement sequence

Table 26. AC characteristics

Sym	Parameter <sup>(1)</sup>	Min	Тур	Max	Units
f <sub>SCL</sub>	SCL clock frequency	0		400	kHz
t <sub>LOW</sub>	Clock low period	1.3			μs
t <sub>HIGH</sub>	Clock high period	600			ns
t <sub>R</sub>	SDA and SCL rise time			300	ns
t <sub>F</sub>	SDA and SCL fall time			300	ns
t <sub>HD:STA</sub>	START condition hold time (after this period the first clock pulse is generated)	600			ns
t <sub>SU:STA</sub>	START condition setup time (only relevant for a repeated start condition)	600			ns
t <sub>SU:DAT</sub> <sup>(2)</sup>	Data setup time	100			ns
t <sub>HD:DAT</sub>	Data hold time	0			μs
t <sub>SU:STO</sub>	STOP condition setup time	600			ns
t <sub>BUF</sub>	Time the bus must be free before a new transmission can start	1.3			μs

<sup>1.</sup> Valid for ambient operating temperature:  $T_A = -40$  to 85 °C;  $V_{CC} = 2.38$  to 5.5 V (except where noted).

<sup>2.</sup> Transmitter must internally provide a hold time to bridge the undefined region (300 ns max) of the falling edge of SCL.

# 6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

52/61 Doc ID 12578 Rev 12

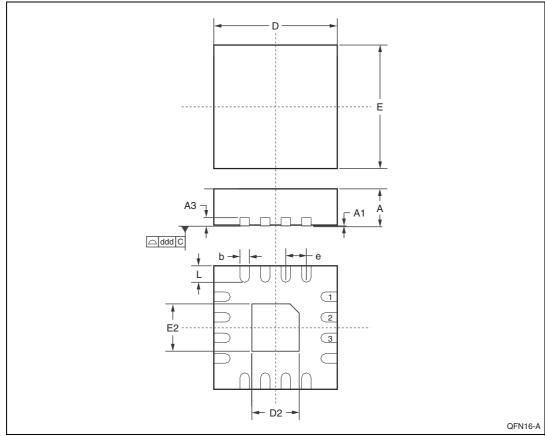


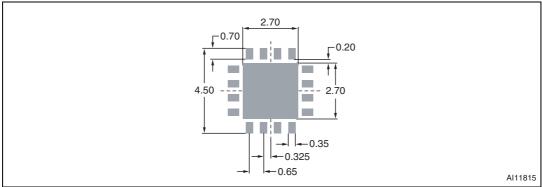
Figure 28. QFN16 - 16-lead, quad, flat package, no lead, 4 x 4 mm body size outline

Note: Drawing is not to scale.

Table 27. QFN16 – 16-lead, quad, flat package, no lead, 4 x 4 mm pack. mech. data

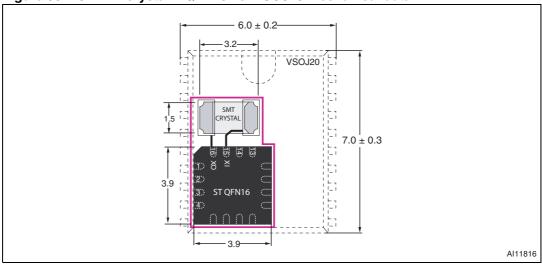
Sym		mm		inches				
Sym	Тур	Min	Max	Тур	Min	Max		
Α	0.90	0.80	1.00	0.035	0.031	0.039		
A1	0.02	0.00	0.05	0.001	0.000	0.002		
А3	0.20	_	_	0.008	_	_		
b	0.30	0.25	0.35	0.012	0.010	0.014		
D	4.00	3.90	4.10	0.157	0.154	0.161		
D2	_	2.50	2.80	-	0.098	0.110		
E	4.00	3.90	4.10	0.157	0.154	0.161		
E2	_	2.50	2.80	ı	0.098	0.110		
е	0.65	-	_	0.026	_	1		
L	0.40	0.30	0.50	0.016	0.012	0.020		
ddd	_	0.08	_	_	0.003	_		

Figure 29. QFN16 – 16-lead, quad, flat package, no lead, 4 x 4 mm, recommended footprint



Note: Dimensions are shown in millimeters (mm).

Figure 30. 32 KHz crystal + QFN16 vs. VSOJ20 mechanical data



Note: Dimensions shown are in millimeters (mm).

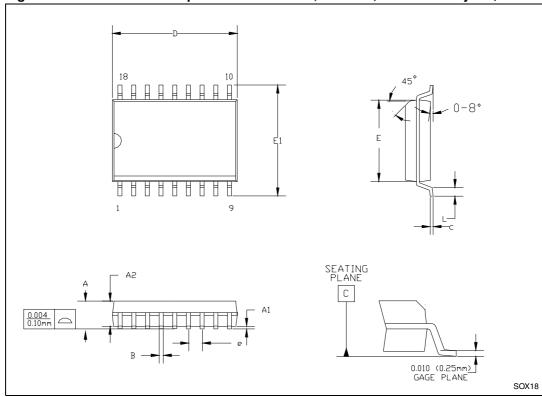


Figure 31. SOX18 - 18-lead plastic small outline, 300 mils, embedded crystal, outline

Note: Drawing is not to scale.

Table 28. SOX18 – 18-lead plastic small outline, 300 mils, embedded crystal, package mech. data

		millimeters			inches		
Symbol		- Illillillilleters	T	inches			
<b>,</b>	Тур	Min	Max	Тур	Min	Max	
Α	2.57	2.44	2.69	0.101	0.096	0.106	
A1	0.23	0.15	0.31	0.009	0.006	0.012	
A2	2.34	2.29	2.39	0.092	0.090	0.094	
В	0.46	0.41	0.51	0.018	0.016	0.020	
С	0.25	0.20	0.31	0.010	0.008	0.012	
D	11.61	11.56	11.66	0.457	0.455	0.459	
E	7.62	7.57	7.67	0.300	0.298	0.302	
E1	10.34	10.16	10.52	0.407	0.400	0.414	
е	1.27	_	_	0.050	_	_	
L	0.66	0.51	0.81	0.026	0.020	0.032	

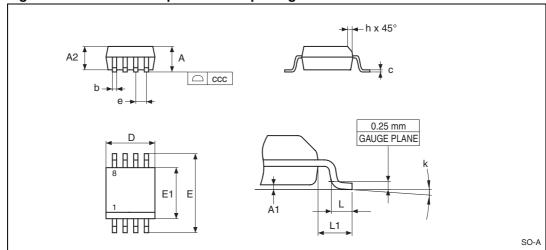


Figure 32. SO8 – 8-lead plastic small package outline

Note: Drawing is not to scale.

Table 29. SO8 – 8-lead plastic small outline (150 mils body width), package mech. data

	uata					
Cumb		mm			inches	
Symb	Тур	Min	Max	Тур	Min	Max
Α			1.75			0.069
A1		0.10	0.25		0.004	0.010
A2		1.25			0.049	
b		0.28	0.48		0.011	0.019
С		0.17	0.23		0.007	0.009
ccc			0.10			0.004
D	4.90	4.80	5.00	0.193	0.189	0.197
E	6.00	5.80	6.20	0.236	0.228	0.244
E1	3.90	3.80	4.00	0.154	0.150	0.157
е	1.27	-	-	0.050	-	-
h		0.25	0.50		0.010	0.020
k		0°	8°		0°	8°
L		0.40	0.127		0.016	0.050
L1	1.04			0.041		

TOP COVER TAPE

CENTER LINES
OF CAVITY

USER DIRECTION OF FEED

AM03073v1

Figure 33. Carrier tape for QFN16, SOX18, and SO8 packages

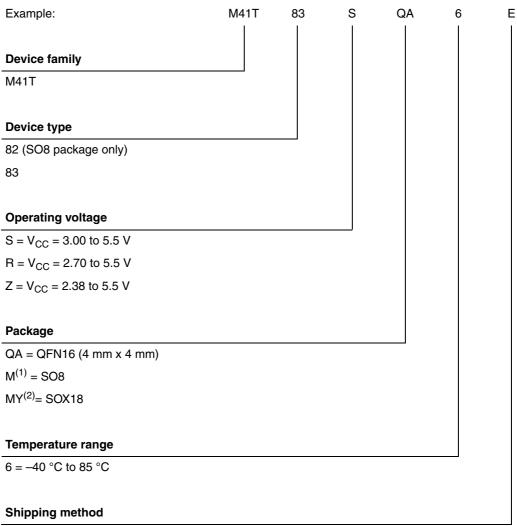
Table 30. Carrier tape dimensions for QFN16, SOX18, and SO8 packages

Package	w	D	E	P <sub>0</sub>	P <sub>2</sub>	F	<b>A</b> <sub>0</sub>	B <sub>0</sub>	K <sub>0</sub>	P <sub>1</sub>	Т	Unit	Bulk Qty
QFN16	12.00 ±0.30	1.50 +0.10/ -0.00	1.75 ±0.10	4.00 ±0.10	2.00 ±0.10	5.50 ±0.05	4.30 ±0.10	4.30 ±0.10	1.10 ±0.10	8.00 ±0.10	0.30 ±0.05	mm	1000
SOX18	24.00 ±0.30	1.50 +0.10/ -0.00	1.75 ±0.10	4.00 ±0.10	2.00 ±0.10	11.50 ±0.10	12.70 ±0.10	11.90 ±0.10	3.20 ±0.10	16.00 ±0.10	0.30 ±0.05	mm	1000
SO8	12.00 ±0.30	1.50 +0.10/ -0.00	1.75 ±0.10	4.00 ±0.10	2.00 ±0.10	5.50 ±0.05	6.50 ±0.10	5.30 ±0.10	2.20 ±0.10	8.00 ±0.10	0.30 ±0.05	mm	2500

Part numbering M41T82-M41T83

# 7 Part numbering





E = ECOPACK® package, tubes

F = ECOPACK® package, tape & reel

- 1. M41T82 only
- 2. The SOX18 package includes an embedded 32,768 Hz crystal.

For other options, or for more information on any aspect of this device, please contact the ST sales office nearest you.

M41T82-M41T83 References

## 8 References

Below is a listing of the crystal component suppliers mentioned in this document.

- KDS can be contacted at kouhou@kdsj.co.jp or http://www.kdsj.co.jp.
- Citizen can be contacted at csd@citizen-america.com or http://www.citizencrystal.com.
- Micro Crystal can be contacted at sales@microcrystal.ch or http://www.microcrystal.com.

Revision history M41T82-M41T83

# 9 Revision history

Table 32. Document revision history

Date	Revision	Changes
09-Apr-2009	9	Updated Table 1, 2, 4, 6, 10, 11, 22, Figure 19, 26, Section 3, Section 3.4.1, Section 3.4.2, Section 3.5, Section 3.6, Section 3.7, Section 3.8, Section 3.8.2, Section 3.8.3, Section 3.8.4, Section 3.8.5, Section 3.12, Section 3.13, Section 6; added Section 3.8.1, Section 3.14, Section 3.15, Table 9, 15, 16, Figure 21, 23; removed "output driver pin" section, "alarm interrupt reset waveform" figure, "backup mode alarm waveform" figure, "timer countdown value register bits (addr 11h)" table; added tape and reel information Figure 33, Table 30.
05-Jan-2010	10	Updated Section 2.2: Read mode, Section 2.3: Write mode, Section 3: Clock operation, Section 3.1: Power-down time-stamp, Section 3.2: Clock/control register map and divider chain, Table 26.
25-Mar-2010	11	Updated Figure 26; Table 25.
19-Oct-2010	12	Updated Note in Section 3.12: Oscillator fail detection.

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